#### INDIAN INSTITUTE OF TECHNOLOGY MADRAS Chennai 600 036



Telephone: [044] 2257 9763 E-mail: tender@imail.iitm.ac.in

The Senior Manager (Project Purchase)

TUR NORD

Date: 18.12.2023

Due Date/Time: 26.12.2023 @ 3:00 PM

Open Tender Reference No: EE/GANT/062/2023/PCBMANASSLY

GEM NAR ID: GEM/GARPTS/13122023/L353KW8A2YMB

Dear Sir/Madam,

On behalf of the Indian Institute of Technology Madras, Tenders are invited in two bid system from Class-I local suppliers and Class II local suppliers, for the supply of: "PCBs Manufacturing and Assembly" Conforming to the specifications given in Annexure -A.

Tender Documents may be downloaded from Central Public Procurement Portal <u>https://etenders.gov.in/eprocure/app</u>. Aspiring Bidders who have not enrolled / registered in e-procurement should enroll / register before participating through the website <u>https://etenders.gov.in/eprocure/app</u>. The portal enrolment is free of cost. Bidders are advised to go through instructions provided at **"Help for contractors"**. [Special Instructions to the Contractors/Bidders for the e-submission of the bids online through this eProcurement Portal"]

Bidders can access tender documents on the website (For searching in the NIC site, kindly go to Tender Search option and type "IIT". Thereafter, click on "GO" button to view all IIT Madras tenders). Select the appropriate tender and fill them with all relevant information and submit the completed tender document online on the website <u>https://etenders.gov.in/eprocure/app</u> as per the schedule attached.

1) Pre-bid Meeting Details	:	NA
2) ICSR Vendor Registration	•	Vendor registration code.       Vendor registration with IC&SR (IITM) is mandatory for bidders to participate in tenders.         ** For Vendor Registration & Guidelines, Please follow the website : <u>https://icandsr.iitm.ac.in/vendorportal;</u> Helpdesk: vendorhelpdesk@icsrpis.iitm.ac.in

<u>No manual bids will be accepted.</u> All tender documents including Technical and Financial bids should be submitted in the E-procurement portal.

Last date for receipt of tender		26.12.2023 @ 3:00 PM
Date & time of opening of tender	:	27.12.2023 @ 3:00 PM

# **<u>3. Instructions to the Bidder:</u>**

A)	Searching for tender documents	:	<ul> <li>There are various search options built in the CPP Portal, to facilitate bidders to search active tenders by several parameters. These parameters could include Tender ID, organization name, location, date, value, etc. There is also an option of advanced search for tenders, wherein the bidders may combine a number of search parameters such as organization name, form of contract, location, date, other keywords etc. to search for a tender published on the CPP Portal.</li> <li>Once the bidders have selected the tenders they are interested in, they may download the required documents / tender schedules. These tenders can be moved to the respective "My Tender" folder. This would enable the CPP Portal to intimate the bidders through SMS / email in case there is any corrigendum issued to the tender document.</li> <li>The bidder should make a note of the unique Tender ID assigned to each tender, in case they want to obtain any clarification / help from the Helpdesk.</li> </ul>
<b>B</b> )	Assistance to bidders		<ul> <li>Any queries relating to the tender document and the terms and conditions contained therein should be addressed to the Tender Inviting Authority for a tender or the relevant contact person indicated in the tender.</li> <li>Any queries relating to the process of online bid submission or queries relating to CPP Portal in general may be directed to the 24x7 CPP Portal Helpdesk. The contact number for the helpdesk is [0120-4200462, 0120-4001002, 0120-4001005]</li> </ul>
<b>C</b> )	Enrollment Process to Bidders	:	<ul> <li>Bidders are required to enroll on the e-Procurement module of the Central Public Procurement Portal URL:https://etenders.gov.in/eprocure/app by clicking on "Online Bidder Enrollment". Enrollment on the CPP Portal is free of charge.</li> <li>As part of the enrolment process, the bidders will be required to choose a unique username and assign a password for their accounts.</li> <li>Bidders are advised to register their valid email address and mobile numbers as part of the registration process. These would be used for any communication from the CPP Portal.</li> <li>Upon enrolment, the bidders will be required to register their valid Digital Signature Certificate (Class II or Class III Certificates with signing key usage) issued by any Certifying Authority recognized by CCA India (e.g. Sify / TCS / nCode / eMudhra etc.)</li> <li>Only one valid DSC should be registered by a bidder. Please note that the bidders are responsible to ensure that they do not lend their DSCs to others which may lead to misuse.</li> <li>Bidder then may log in to the site through the secured log-in by entering their user ID / password and the password of the DSC / eToken.</li> <li>Possession of a Valid Class II/III Digital Signature Certificate (DSC) in the form of smart card/e-token in the company's name is a prerequisite for registration and participating in the bid submission activities</li> </ul>

			<ul> <li>through https://etenders.gov.in/eprocure/app</li> <li>Digital Signature Certificates can be obtained from the authorized certifying agencies, details of which are available in the web site https://etenders.gov.in/eprocure/app under the "Information about DSC".</li> </ul>			
D)	Preparation of bids	•	• Bidder should take into account any corrigendum published on the tender document before submitting their bids.			
			• Please go through the tender advertisement and the tender document carefully to understand the documents required to be submitted as part of the bid. Please note the number of covers in which the bid documents have to be submitted, the number of documents including the names and content of each of the document that need to be submitted. Any deviations from these may lead to rejection of the bid.			
		<ul> <li>Bidder, in advance, should prepare the bid docums ubmitted as indicated in the tender document / schedule and g be in PDF / XLS formats as the case may be. Bid docums canned with 100 dpi with black and white option.</li> <li>To avoid the time and effort required in uploading the standard documents which are required to be submitted as a bid, a provision of uploading such standard documents (e.g. PAGSTIN Details, annual reports, auditor certificates etc.) has b to the bidders. Bidders can use "My Documents" area available upload such documents. These documents may be directly su the "My Documents" area while submitting a bid, and muploaded again and again. This will lead to a reduction in the for bid submission process.</li> </ul>				
E)	E) Submission of bids		• Bidder should log into the site well in advance for bid submission so that he/she can upload the bid in time i.e. on or before the bid submission date and time. Bidder will be responsible for any delay due to other issues.			
			• The bidder has to digitally sign and upload the required bid documents one by one as indicated in the tender document.			
			• Bidder has to select the bid security declaration. Otherwise, the tender will be summarily rejected.			
			• A standard BOQ format has been provided with the tender document to be filled by all the bidders. Bidders are requested to note that they should necessarily submit their financial bids in the format provided and no other format is acceptable. Bidders are required to download the BOQ file, open it and complete the detail with their respective financial quotes and other details (such as name of the bidder). If the BOQ file is found to be modified by the bidder, the bid will be rejected.			
			• The server time (which is displayed on the bidders" dashboard) will be considered as the standard time for referencing the deadlines for submission of the bids by the bidders, opening of bids etc. The bidders should follow this time during bid submission.			
			• The Tender Inviting Authority (TIA) will not be held responsible for any sort of delay or the difficulties faced during the submission of bids online by the bidders due to local issues.			
			• The uploaded tender documents become readable only after the tender opening by the authorized bid openers.			

		<ul> <li>Upon the successful and timely submission of bids, the portal will give a successful bid submission message &amp; a bid summary will be displayed with the bid no. and the date &amp; time of submission of the bid with all other relevant details.</li> <li>Kindly add scanned PDF of all relevant documents in a single PDF file of compliance sheet.</li> <li>More information useful for submitting online bids on the CPP Portal may be obtained at: <u>https://etenders.gov.in/eprocure/app</u>.</li> <li>All tender documents including pre-qualification bid, Technical Bid &amp;Financial Bid should be submitted separately in online CPP portal as per the specified format only. Right is reserved to ignore any tender which fails to comply with the above instructions. No manual bid submission will be entertained.</li> </ul>				
F)	Marking on Technical Bid	• The bidder eligibility criteria, technical specification and supply of item for this tender is given in Annexure B.				
		• The Bidders shall go through the specification and submit the technical bid.				
		• The Technical bid should be submitted in the proforma as per Annexure-B in pdf format only through online (e-tender). No manual submission of bid will be entertained.				
		• The technical bid should have a page-wise heading as "Technical Bid" and page no. in all pages with seal and signature of authorized signatory. The total no. of pages should be mentioned at the last page of the documents.				
		• The technical bid should consist of bidder eligibility criteria details and all technical details along with catalogue/ pamphlet which will give a detailed description of product with technical data sheet so that technical compliance can be verified.				
G)	Marking on Price Bid	• Financial bid (BoQ) should be submitted in the prescribed proforma format as per Annexure-C in xls format through e-tender only. No manual or other form of submission of Financial Bid will not be entertained				

4)	Preparation of Tender: The bidders should submit the bids in two bid system as detailed below.								
	Bid I _Technical Bid								
	The technical bid should consist of bidder eligibility criteria and technical specification compliance sheet as per Annexure-B.								
	Bid II _Price Bid								
	The price bid should be submitted in excel format (BoO) as per the proforma (Annexure C) uploaded in								
	the e-Tender web site. The Quoted price should be for supply and installation of the item and inclusive of all cost and statutory levies at IIT Madras.								
5)	Price:								
	a) The price should be quoted only in INR net per unit (after breakup) and must include all packing, transit insurance and delivery charges to the <b>Department of Electrical Engineering</b> .								
	b) The rate quoted shall be all inclusive of all taxes and no extra payment will be made other than statutory revisions as per the terms and conditions stipulated in this contract document								
	c) The percentage of tax & duties should be clearly indicated separately. IIT Madras is eligible for custom duty (5.5%). Relevant certificates will be issued wherever necessary								
	<ul> <li>d) The offer/bids should be submitted through online only in two bid system i.e. Technical Bid and Financial Bid separately.</li> </ul>								
6)	Tenderer shall submit along with this tender:								
	(i) Proof of having ISO or other equivalent certification given by appropriate authorities.								
	(ii) Name and full address of the Banker and their swift code and PAN No. and GSTIN number.								
	(iii) GST registration proof showing registration number, area of registration etc.								
	(iv) All of your future correspondences including Invoices should bear the GST No. and Area Code.								
7)	Terms of Delivery:								
	Supplier will be fully responsible for the safe carriage, Installation/Commissioning of goods up to the <b>Department of Electrical Engineering</b> , IIT Madras or named place as per PO, Insurance coverage will be in the scope of the supplier.								
	The tenderer should indicate clearly the time required for delivery of the item (subject to the approval of the Executive Committee-IIT-Madras). In case there is any deviation in the delivery schedule, liquidated damages clause will be enforced or penalty for the delayed supply period will be levied.								
	In the event of delay or non-supply of materials/execution of Contract beyond the date of delivery/completion of job. The penalty will be levied @1% per week of delay subject to a max of 10% of the value of purchase order and if the delay is more than accepted time frame by IIT M, the PO would be partially or fully cancelled and liquidated damages will be enforced accordingly.								
8)	Period for which the offer will remain open:								
	The Tender shall remain open for acceptance/validity till: 120 days from the date of opening of the tender. However, the day up to which the offer is to remain open being declared closed holiday for the Indian Institute of Technology Madras, the offer shall remain open for acceptance till the next working day.								

9)	EMD:
	The EMD of Rs. 1,40,000 to be transferred to the account details mentioned in Annexure D and proof should be enclosed in the Technical Bid. Any offer not accompanied with the EMD shall be rejected summarily as non-responsive.
	The EMD of the unsuccessful bidders shall be returned within 30 days of the end of the bid validity period. The same shall be forfeited, if the tenderers withdraw their offer after the opening during the bid validity period. The Institute shall not be liable for payment of any interest on EMD.
	EMD is exempted for Micro and Small Enterprises (MSE) as defined in MSE Procurement Policy issued by Department of Micro, Small and Medium Enterprises (MSME) and Startups as recognized by Department of Industrial Policy & Promotion (DIPP). (MSE/MSME/DIPP PROOF should be enclosed
	in the cover containing technical bid).
10)	Performance Security: -
	The successful bidder should submit Performance Security for an amount of 5% of the value of the contract/supply. The Performance Security may be furnished in the form of an Account Payee DD, FD Receipt in the name of "The Registrar, IIT Madras" from any scheduled commercial bank or Bank Guarantee from any scheduled commercial bank in India. The performance security should be furnished within 14 days from the date of the purchase order.
	Performance Security in the form of Bank Guarantee: - In case the successful bidder wishes to submit Performance Security in the form of Bank Guarantee, the Bank Guarantee should be routed directly to IIT Madras from the Bank.
	The Bank Guarantee should remain valid for a period of sixty days beyond the date of completion of all contractual obligations of the supplier including the warranty obligations.
11)	For the same tender, either the OEM or the authorized dealer/service provider can only quote. But bothof them cannot quote separately for the same tender.
12)	The offers/bids should be sent only for a item/Equipments of latest version that is available in the market and supplied to a number of customers. A list of customers in India with details must accompany the quotations. Quotations for a prototype machine will not be accepted
13)	Original catalogue (not any photocopy) of the quoted model duly signed by the principals must accompany the quotation in the Technical bid.
14)	Compliance or Confirmation report with reference to the specifications and other terms & conditions should also be obtained from the principal/OEM.
15)	Risk Purchase Clause
	In the event of failure of supply of the item/equipment within the stipulated delivery schedule, the purchaser has all the right to purchase the item/equipment from other sources on the total risk of the supplier under risk purchase clause.
16)	<ul> <li>Payment: <ol> <li>Two-stage payment</li> <li>Two-stage payment</li> </ol> </li> <li>Stage 1: 40% Payment will be done once stage 1 is completed and is delivered.</li> <li>Stage 2: 60% Payment will be done once stage 2 is completed and is delivered.</li> <li>Advance Payment: No advance payment is generally admissible. In case a specific percentage of advance payment is required, the Vendor has to submit a Bank Guarantee from a scheduled commercial bank in India equivalent to the amount of advance payment.</li> </ul>
17)	On-site Installation:
	The equipment/item or Machinery has to be installed or commissioned by the successful bidder within the number of days (as prescribed by PI) from the date of receipt of the item at the site of IIT Madras.

18)	Warranty/Guarantee:
	The offer should clearly specify the warranty or guarantee period for the machinery/equipment. Any extended warranty offered for the same has to be mentioned separately (For more details please refer our Technical Specifications).
	** Note: PO which involves installation, warranty/guarantee shall be applicable from date of installation.
<b>19</b> )	Acceptance and Rejection:
	Failure to comply with any of the instructions stated in this document or offering unsatisfactory explanations for non-compliance will likely to lead to rejection of offers.
	I.I.T. Madras has the right to accept the whole or any part of the Tender or portion of the quantity offered or reject it in full without assigning any reason.
20)	Debarment from Bidding:
	In case of breach of Terms & Conditions, Bidder may be suspended from being eligible for bidding in any contract with the IIT Madras up to 2 Years [as per Rule 151(iii) of GFR] from the date of Tender.
21)	Disputes and Jurisdiction:
	<b>Settlement of Disputes:</b> Any dispute, controversy or claim arising out of or in connection with this PO including any question regarding its existence, validity, breach or termination, shall in the first instance be attempted to be resolved amicably by both the Parties. If attempts for such amicable resolution fails or no decision is reached within 30 days whichever is earlier, then such disputes shall be settled by arbitration in accordance with the Arbitration and Conciliation Act, 1996. Unless the Parties agree on a sole arbitrator, within 30 days from the receipt of a written request by one Party from the other Party to so agree, the arbitral panel shall comprise of three arbitrators. In that event, the supplier will nominate one arbitrator and the Project Coordinator of IITM shall nominate on arbitrator. The Dean IC&SR will nominate the Presiding Arbitrator of the arbitral tribunal. The arbitration proceeding shall be carried out in English language. The cost of arbitration and fees of the arbitrator(s) shall be shared equally by the Parties. The seat of arbitration shall be at IC&SR IIT Madras, Chennai. a. The Applicable Law: The Purchase Order shall be construed, interpreted and governed by the Laws of India. Court at Chennai shall have exclusive jurisdiction subject to the arbitration clause. b. Any legal disputes arising out of any breach of contact pertaining to this tender shall be settled in the court of competent jurisdiction located within the city of Chennai in Tamil Nadu.
22)	<ul> <li>Force Majeure: The Supplier shall not be liable for forfeiture of its performance security, liquidated damages or termination for default, if and to the extent that, it's delay in performance or other failure to perform its obligations under the Contract is the result of an event of Force Majeure.</li> <li>For purposes of this Clause, "Force Majeure" means an event beyond the control of the Supplier and not involving the Supplier's fault or negligence and not foreseeable. Such events may include, but are not limited to, acts of the Purchaser either in its sovereign or contractual capacity, wars or revolutions, fires, floods, epidemics, quarantine restrictions and freight embargoes.</li> <li>If a Force Majeure situation arises, the Supplier shall promptly notify the Purchaser in writing of such conditions and the cause thereof. Unless otherwise directed by the Purchaser in writing, the Supplier shall continue to perform its obligations under the Contract as far as is reasonably practical, and shall</li> </ul>
	seek all reasonable alternative means for performance not prevented by the Force Majeure event.
	seek an reasonable alternative means for performance not prevented by the Force Majeure event.

23)	Eligibility Criteria:
	As per the Government of India Order, only "Class - I Local Suppliers" and "Class - II Local Suppliers" <u>can participate in this tender.</u>
	<b>Bidder should confirm their acceptance that they comply with the provisions with report to</b> "Guidelines for eligibility of a bidder from a country which shares a land border with India as detailed at Annexure-F. The bidder should submit Certificate for "Bidder from/ Not from Country sharing Land border with India & Registration of Bidder with Competent Authority" as per Order of DoE F.No.6/18/2019-PPD dated 23.07.2020 as mentioned.
24)	<b>Preference to "class I Local Suppliers"</b> : preference will be given to " <b>class 1 local suppliers</b> " (subject to class -I local supplier's quoted price falling within the margin of purchase preference ) as per public programment (preference to make in India) order 2017. O M No P. 45021/2/2017 pr(PE 11) dt
	procurement (preference to make in India) order 2017 .O.M No P- 45021/2/2017 – pp(BE - 11) dt 04/06/2020 subject to the conditions that the "class 1 Local Supplier" should agree to supply goods / provide service at L1 rate and furnish a certificate with the technical bid document that the goods/service provided by them consists local content equal to or more than 50%.( certificate from Chartered Accountant in case value of contract exceeds Rs 10 crore).
	<b>Class - I local supplier</b> " means a supplier or service provider whose goods, services or works offered for procurement consists of local content equal to or more than 50% as defined under the above said order. <b>Declaration to be provided as per Annexure-II per item/service/work.</b>
	<b>"Class - II local supplier"</b> means a supplier or service provider whose goods, services or works offered for procurement consists of local content equal to 20% but less than 50% as defined under the above said order. <b>Declaration to be provided as per Annexure-II per item/service/work.</b>
	"Margin of purchase preference": - The margin of purchase preference shall be 20%. The Definition of the margin of purchase preference is defined in the Govt. of India Order No: P-45021/12/2017-PP (BE-II) Dt.4th June, 2020) Order 2017. As per the Government of India Order –
	"Margin of Purchase Preference" means the maximum extent to which the price quoted by a "Class-I local supplier" may be above the L1 for the purpose of purchase preference.
	**Note: Local content percentage to be calculated in accordance with the definition provided at clause 2 of revised public procurement preference to Make in India Policy vide GoI Order no. P-45021/2/2017-PP (B.EII) dated 15.06.2017 (subsequently revised vide orders dated 28.05.2018,
	45021/2/2017-PP (B.EII) dated 15.06.2017 (subsequently revised vide orders dated 28.05.2018, 29.05.2019and 04.06.2020) MOCI order No. 45021/2/2017-PP (BE II) Dt.16th September 2020 & P- 45021/102/2019-BE-II-Part(1) (E-50310) Dt.4th March 2021

25)	Evaluation of Bids
23)	Bid evaluation will take place in two stages.
	Stage I Technical Bid evaluation
	All bidders who have fully complied with bidder eligibility criteria I, II and technical evaluation
	(Annexure B) will only be considered for opening of price bid.
	Stage II: Price Bid Evaluation
	The price bid evaluation will be based on price quoted by the bidder. The rate quoted for PCBs
	Manufacturing and Assembly unit will alone be taken up for arrival of Lowest Bid (L1) value.
26)	In accordance to the Rule 173 of GFR,2017 and relevant provisions thereof in Procurement Manuals, 2022,IC&SR, IITM reserves the right to carry out the negotiation process through its purchase/technical committee with L1/H1 (as applicable) vendor to ensure price reasonability before final recommendation
	to the Competent Authority. The negotiation details, if any, on case to case basis shall be recorded in
	minutes of meetings suitably for records.
27)	Selection of successful bidder and Award of Order
	The order will be directly awarded to the technically qualified bidder as per the condition in para 3A of
	DIPP, MoCI Order No. 45021/2/2017-PP (BE II) dated 16th September 2020.
28)	All information including selection and rejection of technical or financial bids of the prospective bidders
/	will be communicated through e-Tender portal. In terms of Rule 173(iv) of General Financial Rule 2017,
	the bidder shall be at liberty to question the bidding conditions, bidding process and/or rejection of bids.
29)	The tenderer shall certify that the tender document submitted by him / her are of the same replica of the
	tender document as published by IIT Madras and no corrections, additions and alterations made to the
	same. If any deviation found in the same at any stage and date, the bid / contract will be rejected /
	terminated and actions will be initiated as per the terms and conditions of the contract.
111	Clarification to the queries and doubts raised by the bidders will be issued as a corrigendum/addendum in
t	he e-tenders portal.
31)	In the e-tender process, participation of bidders after the due date is not possible. The eligible bidders can
~1)	login to the e-Procurement portal to ascertain the tender status.

### **ACKNOWLEDGEMENT**

It is hereby acknowledged that I/We have gone through all the points listed under "Specification, Guidelines, Terms and Conditions" of tender document. I/We totally understand the terms and conditions and agree to abide by the same.

# SIGNATURE OF TENDERER ALONG WITH SEAL OF THE COMPANY WITH DATE

#### Bidder Eligibility Criteria and Technical Specification for PCBs Manufacturing and Assembly Tender No. EE/GANT/062/2023/PCBMANASSLY

#### Bidder Eligibility Criteria – I (Public Procurement – Preference to Make in India)

Only 'Class-I local suppliers' and 'Class-II local suppliers', as defined under DIPP, MoCI Order No. P-45021/2/2017-PP (BE-II) dated 16<sup>th</sup> September 2020 and other subsequent orders issued therein.

### CHECKLIST

### Please ensure that the following compliance sheets are in your technical bid

Particulars
Compliance sheet: 1
Compliance sheet: 2
Compliance sheet: 3
Compliance sheet: SOM
Compliance sheet: Integrated Mother Board
Compliance sheet: SOM EVK Mother Board

The technical details for PCB and assembly are provided below. The BOM for the boards will be provided as Excel sheet upon request. Please email rganti@ee.iitm.ac.in and subashini@5gtbiitm.in

### **Bidder Eligibility Criteria – II**

- 1. The Firm should have a minimum turnover of 5 crores/year.Evidence should be provided.
- 2. The vendor must provide proof of business with other clients (atleast 2) in the past year and can provide client references.
- 3. The Firm should be in business for a minimum of 5 years. Evidence should be provided.
- 4. Please indicate prior High-Speed FPGA and high-power RF boards (of similar complexity of at least 12 layers) that you have fabricated. Vendors without prior experience (of at least two prior boards) of similar complexity will be disqualified. Documentary evidence of the same should be provided.
- 5. Explicitly indicate the PCB Fab details for each board and <u>its technical capabilities</u>, where each board will be fabricated. References to online material/documentation for verification <u>should</u> be provided. The bid might be disqualified if the technical capabilities of the proposed FAB are not clear or do notmeet the technical requirements of the boards.
  - 1) The country of the FAB should explicitly be mentioned.
    - a. If these boards are manufactured in countries that sharea land border with India, the bid will be eligible only if the FAB is registered with the competent authority and the required approvals are obtained as mentioned in the GFR amendments (<u>Rule 144 (xi</u>)) posted on 23<sup>rd</sup> July 2020.
    - b. These required approvals have to be part of the technicaltender for the bid to be valid.

6. Prior engineering compliance with the FAB (for meeting the technical specifications, as mentioned in the subsequent sections) for manufacturing the required PCB should be provided (for each PCB) in the templates provided in the next sections.

1. The confirmation from the FAB (as email exchange or letters (in English)) should also be provided in the tender.

- 2. Some important considerations
  - Most of the boards require blind vias.
  - Impedance control is required
- 7. Explicitly indicate the plant details **and its technical capabilities**, where the board will be assembled.
- 8. Please indicate the country of the assembly facility. <u>The assembly facility should</u> be in India
  - Where IITM can ship the required components (FPGA's, ICs, Transceivers)
  - The assembly plant and testing facility should be in India and should be ready for rework as the case arises without additional cost
  - Support for double-sided PCB assembly
- 9. Assembly should have the capability of IPC-610 class2 and class 3 standards

10. The assembly line should be capable of handling 01005 discrete

components, 0.4 mm BGA's, 0.4 mm pitch, LGA CC-20-3, and should have the capability of odd angle placement

- 11. Assembly Should have the facility for flying probe testers and automated optical lines (inspection)
- 12. Assembly should have in house X-ray inspection should be available.

### **III.** Technical Specification for PCBs Manufacturing and Assembly

### 1) Technical Specifications, quantities for compliance

The following boards are going to be manufactured. All the boards have two stages of manufacturing.

**Stage1:** PCB fab and assembly for X no of boards. The exact numbers for assembled and bare boards are provided below.

Stage 2: PCB fab and assembly for Y no of boards. The exact numbers for assembled are provided below.

S No	Board name		Quantity for Sta	Quantity for Stage 2	Total	
S. No	board name	Bare Board	Power & Clock Board	Full Assembly	Full Assembly	Quantity
1	SOM	1	1	4	14	20
2	Integrated Mother Board	1	0	2	4	7
3	SOM EVK Mother Board	1	0	2	4	7

# \*There will be minor design changes between Stage 1 and Stage 2.

### **Compliance Sheet 1:**

S.	
No	
1	There may be design changes in the PCBs (schematics and layout) between Stage 1 and Stage2. Also a few components (around 5%)might change based on the outcomes of each stage.
	The Vendor should be able to accommodate these.
2	Open, Short, and Impedance reports must be submitted before and after Assembly to IIT Madras for validation of the quality of Fabrication and Assembly for 1 <sup>st</sup> Stage. (Exact Test points will be shared along with Gerbers)
3	Complete Test Procedure with detailed Steps will be shared for the 2nd Stage, In addition to Open Short and Impedance testing this includes: 1. Power On test 2. Clock Programming 3. Booting
4	IIT Madras only will be paying for boards that have passed the tests and been approved and validated by IITM

### **Compliance sheet 2:**

1. Turnaround time from the receipt of the PO till the fabrication and assembly of the boards for Stage 1 - 8Weeks

2. Turnaround time from the receipt of the go ahead till the fabrication and assembly of the boards for Stage 2 - 8 Weeks

### TERMS AND CONDITIONS

### **Compliance sheet 3**

- 1. The delivery time cannot be changed
- 2. All the boards have been quoted. If some boards are not quoted the vendor will be dis-qualified
- 3. The stack up, PCB pre-peg and Core materials of the boards, the via and Trace dimensions and any technical specifications of these boards were **designed after extensivesimulations and will be impossible to change.**

### Attached Stack-up has been verified by the following Fabricators:

- 1) <u>HiQ</u>
- 2) <u>Phase-3</u>
- 3) <u>Micro-pack</u>

We encourage the bidders to Fabricate boards from the above Vendors

for quick turn around time. But, bidders are allowed to Fabricate with any other reputed Vendor(as per the tender clauses) as along as the Stack-up and Timeline remains same

4. Basic rework might be requested (as required) and the vendor should support this without any additional cost

- 5. PCB fabrication: At the end of Stage1, the firm should provide us with a report on the PCBs that were fabricated and assembled and proceed with the assembly only after technical approval by the IITM team.
- 6. In the financial bid, the fabrication cost of each PCB, BOM cost, and Assembly cost are separately and explicitly mentioned.
- 7. Will provide the BOM as per the requirements for all the boards. <u>The BOMfor the boards will be provided</u> <u>as excel sheet upon request. Please email rganti@ee.iitm.ac.in and subashini@5gtbiitm.in. Part of the BOM</u> <u>for assembly will be provided by IIT-Madras.</u>
- 8. BOM supplied by the Vendor should have warranty and COC certification

# **2 BOARD FABRICATION SOM**

### Compliance Sheet SOM

- 1. Country where PCB will be manufactured.
- 2. FAB name where PCB will be manufactured.
- 3. FAB technical capability details are provided (As separate sheets)
- 4. Company where PCB will be Assembled in India

S. No	Description	Specification					
Α	PCB FABRICATION						
1	No. of layers	16					
2	Via Technology	Through Hole and Blind Via With back drilling option					
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40					
4	Impedance control (Yes/No) Mention tolerance	Yes					
5	Board thickness	Entire board must be:					
	(1.6mm/2.4mm/3.2mm/ any other)	73.879mil thickness over the					
	Mention Tolerance	laminate					
		77.579mil thickness over the					
		copper					
		79.579mil thickness over the					
		Solder mask					
6	Copper finish (35 microns/70 microns/ any other)	Copper Thickness:					
		• Outer Layers:					
		a. Signal Layer Thickness 1.85mil					
		• Inner Layers:					
		a. Signal Layer Thickness 0.689 m					
		b. Power (Including ground)					
		layers 0.689 mil and 2.638 mil					

7	Min. finished hole dia (mil)	8 Mil Mech
8	Min. trace width (mil)	3
9	Min. spacing (mil)	3
10	Min. Annular ring (mil)	6
11	Board finish(Hot Air Levelled/ Electroless	Enig
	Ni-Au / Hard Gold / any other)	
12	PCB Dimension in mm	125 mm X 90 mm +/- 10%
13	Metal core board	No
14	Mil Grade	No
15	Whether Group B Test Report required	No
16	Solder Mask Colour	Green
17	Silkscreen Colour	White
18	RoHS Complaint	Yes
19	UL Logo Required	Yes
20	Back Drilling Required	No
21	RF VIAS	No
В	STACKUP REQUIREMENTS	
22	Customer required thickness	73.196+/-7.319 mils Measured:
		Over mask on plated copper
23	Specify Compliance to the Stack up at the bottom	
24	Specify Compliance to the Impedance table at the bottom	
С	ASSEMBLY	
25	No of comps per board	1000
25	No of BGAs per board	10
20	Maximum pin count	1516, 1 mm BGA
27	Minimum BGA pitch	1 mm
28	Total No of points to be soldered (no of	6000(approx)
_>	Pins)	
30	PTH pins	300
31	Both side assembly	Yes
32	Board Size-	125 mm X 90 mm+/- 10%
33	Board Thickness	79.579 Mils
34	No of Layers	16
35	X-ray verification of all BGA's, LPA and	Yes. Test results should be
	QFN	provided.
36		Yes, Report needed
	AOI report for the components	res, Report needed

	_						_				· · · · · · · · · · · · · · · · · · ·
								Isolation			
Laver				<b>C</b> 1	ick up	Description	Processed Thickness	Distance (Summed)	Copper Coverage	Er	Impedance ID
Layer	_			518	юк ир	•		(summed)	Coverage		Impedance ID
	- +					Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	
1	- 1	- <b>+</b> _	4			Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6
	- 1				M.	Isola I-TERA MT40 PP 1086 RC68	3.345	3.345		3.260	
2	- 1					Copper Foil 12 microns	1.850		70.000		
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524		3.240	
	- 1				1/	Isola I-TERA MT40 PP 1067 RC69	2.262	-		3.240	
3	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330	7, 8, 9, 10, 11, 12
4	- 1						0.689	0.000	75.000	0.000	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
5	- 1						0.689		60.000		13, 14, 15, 16, 17, 18
6	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	75.000	3.330	
	- 1	- 1 7				Isola I-TERA MT40 PP 1035 RC67	1,936	3.873		3.280	
	- 1	1				Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
7	- 1						1,260		75.000		
	_					Isola I-TERA MT40 4 mil core 1/2[2x1035]	4.000	4.000		3.280	
8	79.58	28					2.638		75.000		
	~	77.58				Isola I-TERA MT40 PP 1067 RC76	2.340	4.681		3.080	
9	- 1					Isola I-TERA MT40 PP 1067 RC76	2.340	-	75.000	3.080	
-	- 1					Isola I-TERA MT40 4 mil core 2/1[2x1035]	4.000	4.000		3.280	
10	- 1						1.260		75.000		
	- 1					Isola I-TERA MT40 PP 1035 RC67	1.936	3.873		3.280	
	- 1					Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
11	- 1					Isola I-TERA MT40 3 mil core H/H(1x1078)-VLP2	0.689 3.000	3.000	75.000	3.330	
12	- 1					Isola I-TERX MT40 3 mil core PVH[1x1078]-VEP2	0.689	3.000	60.000	3.330	19, 20, 21, 22, 23, 24
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
13	- 1						0.689		75.000		
14	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	60.000	3.330	25, 26, 27, 28, 29, 30
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524	00.000	3.240	25, 25, 27, 25, 25, 55
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262			3.240	
15	- 1					Copper Foil 12 microns	1.850		70.000	0.240	
	- 1				1	Isola I-TERA MT40 PP 1086 RC68	3.345	3.345	70.000	3.260	
				1		ISUA PIERA MINO PP 1000 RC00	3.343	3.343		3.200	
								Isolation			
Layer				Ster	ok up	Description	Processed Thickness	Distance (Summed)	Copper Coverage	εr	Impedance ID
			i v					(Summed)		13	
16	- L	<u> </u>	1	1		Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36
						Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	

Cooper Thickness = 20.709 | Dielectric Thickness = 56.869 | Solder Mask Thickness = 2.000 Stack Up Thickness = 77.579 | Stack Up Thickness with Soldermask = 79.579

Impedance Impedance D         Impedance Signal Layer         Impedance Signal Structure Name         Fer. Plane 1 in Layer         Fer. Plane 2 Width         Fer. Separation (S1)         Ground Separation (S1)         Target Display         Target Target (%)         Target Target (%)         Target Target (%)         Target (%)         Target (%)         Target (%
ID         Löyer         Structure Name         In Layer         (V11)         (S1)         (D1)         Impedance         Impedance         %)           1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         50.080         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.200         0.000         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         89.970         90.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.000         0.000         40.120 <t< td=""></t<>
1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         9.000         50.080         50.000         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Striphine 1B1A         2         4         5.000         0.000         80.000         80.000         10.000           8         3         Edge Coupled Offset Striphine 1B1A         2
3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
6         1         Edge Coupled Costed Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         10.000
8 3 Edge Coupled Offset Stripline 1B1A 2 4 5.000 5.200 0.000 80.000 80.000 10.000
9 3 Offset Stripline 1B1A 2 4 3.600 0.000 0.000 49.840 50.000 10.000
10 3 Edge Coupled Offset Stripline 1B1A 2 4 3.500 9.000 0.000 99.860 100.000 10.000
11 3 Edge Coupled Offset Stripline 1B1A 2 4 4.500 5.500 0.000 85.050 85.000 10.000
12 3 Edge Coupled Offset Stripline 1B1A 2 4 4.000 5.400 0.000 90.090 90.000 10.000
13 5 Offset Stripline 1B1A 4 6 3.600 0.000 0.000 49.450 50.000 10.000
14 5 Offset Stripline 1B1A 4 6 5.400 0.000 0.000 39.750 40.000 10.000
15 5 Edge Coupled Offset Stripline 1B1A 4 6 3.500 9.000 0.000 99.150 100.000 10.000
16 5 Edge Coupled Offset Stripline 1B1A 4 6 4.500 5.500 0.000 84.480 85.000 10.000
17 5 Edge Coupled Offset Stripline 1B1A 4 6 4.000 5.400 0.000 89.530 90.000 10.000
Impedance Ref. Ref. Trace Trace Strip
Impedance Signal ID Layer Structure Name Plane 1 Plane 2 Width Separation Separation Calculated Target Tol (+/- ID Layer Structure Name in Layer (W1) (S1) (D1) Impedance Impedance %)
18 5 Edge Coupled Offset Stripline 1B1A 4 6 5.000 5.200 0.000 79.440 80.000 10.000
19 12 Offset Stripline 1B1A 11 13 3.600 0.000 0.000 49.450 50.000 10.000
20 12 Offset Stripline 1B1A 11 13 5,400 0,000 0,000 39,750 40,000 10,000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000
21 12 Edge Coupled Offset Stripline 1B1A 11 13 3.500 9.000 0.000 99.150 100.000 10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         9.000         49.840         50.000         10.0000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         90.860         100.000         10.000           28         14         Edge Coup
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         90.000         10.000           28         14         Edge Coupled Offset Stripline 1B1A
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         99.860         100.000         10.000           28         14         Edge Coup

# **3 BOARD FABRICATION INTEGRATED MOTHER BOARD**

### **Compliance Sheet SOM**

- 1. Country where PCB will bemanufactured
- 2. FAB name where PCB will bemanufactured.
- 3. FAB technical capability details are provided (As separate sheets)
- 4. Company where PCB will beAssembled in India

S. No	Description	Specification					
А	PCB FABRICATION						
1	No. of layers	16					
2	Via Technology	Through Hole and Blind Via With back drilling option					
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40					
4	Impedance control (Yes/No) Mention tolerance	Yes					
5	Board thickness	Entire board must be:					
	(1.6mm/2.4mm/3.2mm/ any other) Mention Tolerance	<ul> <li>73.879mil thickness over the</li> <li>laminate</li> <li>77.579mil thickness over the</li> <li>copper</li> <li>79.579mil thickness over the</li> <li>Solder mask</li> </ul>					
6	Copper finish (35 microns/70 microns/ any other)	<ul> <li>Copper Thickness:</li> <li>Outer Layers: <ul> <li>a. Signal Layer Thickness 1.85mil</li> <li>Inner Layers:</li> <li>c. Signal Layer Thickness 0.689 ml</li> <li>d. Power (Including ground)</li> <li>layers 0.689 mil and 2.638 mil</li> </ul> </li> </ul>					
7	Min. finished hole dia (mil)	8 Mil Mech					
8	Min. trace width ( mil )	3					
9	Min. spacing (mil)	3					
10	Min. Annular ring (mil)	6					
11	Board finish(Hot Air Levelled/ Electroless Ni-Au / Hard Gold / any other)	Enig					

12	PCB Dimension in mm	450 mm X 400 mm +/- 10%
13	Metal core board	No
14	Mil Grade	No
15	Whether Group B Test Report required	No
16	Solder Mask Colour	Green
17	Silkscreen Colour	White
18	RoHS Complaint	Yes
19	UL Logo Required	Yes
20	Blind Vias Buried Vias Back Drilling Required	Yes
21	RF VIAS	No
В	Stackup Requirements	
22	Customer required thickness	73.196+/-7.319 mils Measured: Over mask on plated copper
23	Specify Compliance to the Stack up at the bottom	
24	Specify Compliance to the Impedance table at the bottom	
С	Assembly	
25	No of comps per board	500
26	No of BGAs per board	10
27	Maximum pin count	540, 1 mm LPGA
28	Minimum BGA pitch	0.8 mm
29	Total No of points to be soldered (no of Pins)	6000(approx)
30	PTH pins	300
31	Both side assembly	Yes
32	Board Size-	450 mm X 400 mm+/- 10%
33	Board Thickness	79.579 Mils
34	No of Layers	16
34 35	No of LayersX-ray verification of all BGA's, LPA and QFN	16 Yes. Test results should be provided.
	X-ray verification of all BGA's, LPA and	Yes. Test results should be

	_						_				· · · · · · · · · · · · · · · · · · ·
								Isolation			
Laver				<b>C</b> 1	ick up	Description	Processed Thickness	Distance (Summed)	Copper Coverage	Er	Impedance ID
Layer	_			518	юк ир	•		(summed)	Coverage		Impedance ID
	- +					Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	
1	- 1	- <b>+</b> _	4			Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6
	- 1				M.	Isola I-TERA MT40 PP 1086 RC68	3.345	3.345		3.260	
2	- 1					Copper Foil 12 microns	1.850		70.000		
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524		3.240	
	- 1				1/	Isola I-TERA MT40 PP 1067 RC69	2.262	-		3.240	
3	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330	7, 8, 9, 10, 11, 12
4	- 1						0.689	0.000	75.000	0.000	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
5	- 1						0.689		60.000		13, 14, 15, 16, 17, 18
6	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	75.000	3.330	
	- 1	- 1 7				Isola I-TERA MT40 PP 1035 RC67	1,936	3.873		3.280	
	- 1	1				Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
7	- 1						1,260		75.000		
	_					Isola I-TERA MT40 4 mil core 1/2[2x1035]	4.000	4.000		3.280	
8	79.58	28					2.638		75.000		
	~	77.58				Isola I-TERA MT40 PP 1067 RC76	2.340	4.681		3.080	
9	- 1					Isola I-TERA MT40 PP 1067 RC76	2.340	-	75.000	3.080	
-	- 1					Isola I-TERA MT40 4 mil core 2/1[2x1035]	4.000	4.000		3.280	
10	- 1						1.260		75.000		
	- 1					Isola I-TERA MT40 PP 1035 RC67	1.936	3.873		3.280	
	- 1					Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
11	- 1					Isola I-TERA MT40 3 mil core H/H(1x1078)-VLP2	0.689 3.000	3.000	75.000	3.330	
12	- 1					Isola I-TERX MT40 3 mil core PVH[1x1078]-VEP2	0.689	3.000	60.000	3.330	19, 20, 21, 22, 23, 24
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
13	- 1						0.689		75.000		
14	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	60.000	3.330	25, 26, 27, 28, 29, 30
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524	00.000	3.240	25, 25, 27, 25, 25, 55
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262			3.240	
15	- 1					Copper Foil 12 microns	1.850		70.000	0.240	
	- 1				1	Isola I-TERA MT40 PP 1086 RC68	3.345	3.345	70.000	3.260	
				1		ISUA PIERA MINO PP 1000 RC00	3.343	3.343		3.200	
								Isolation			
Layer				Ster	ok up	Description	Processed Thickness	Distance (Summed)	Copper Coverage	εr	Impedance ID
			i v					(Summed)		13	
16	- L	<u> </u>	1	1		Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36
						Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	

Cooper Thickness = 20.709 I Delectric Thickness = 56.869 I Solder Mask Thickness = 2.000 (Stack Up Thickness = 77.579 I Stack Up Thickness with Soldermask = 79.579

Impedance Impedance D         Impedance Signal Layer         Impedance Signal Structure Name         Fer. Plane 1 in Layer         Fer. Plane 2 Width         Fer. Separation (S1)         Ground Separation (S1)         Target Display         Target Target (%)         Target Target (%)         Target Target (%)         Target (%)         Target (%)         Target (%
ID         Löyer         Structure Name         In Layer         (V11)         (S1)         (D1)         Impedance         Impedance         %)           1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         50.080         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.200         0.000         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         89.970         90.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.000         0.000         40.120 <t< td=""></t<>
1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         9.000         50.080         50.000         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Striphine 1B1A         2         4         5.000         0.000         80.000         80.000         10.000           8         3         Edge Coupled Offset Striphine 1B1A         2
3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
6         1         Edge Coupled Costed Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         10.000
8 3 Edge Coupled Offset Stripline 1B1A 2 4 5.000 5.200 0.000 80.000 80.000 10.000
9 3 Offset Stripline 1B1A 2 4 3.600 0.000 0.000 49.840 50.000 10.000
10 3 Edge Coupled Offset Stripline 1B1A 2 4 3.500 9.000 0.000 99.860 100.000 10.000
11 3 Edge Coupled Offset Stripline 1B1A 2 4 4.500 5.500 0.000 85.050 85.000 10.000
12 3 Edge Coupled Offset Stripline 1B1A 2 4 4.000 5.400 0.000 90.090 90.000 10.000
13 5 Offset Stripline 1B1A 4 6 3.600 0.000 0.000 49.450 50.000 10.000
14 5 Offset Stripline 1B1A 4 6 5.400 0.000 0.000 39.750 40.000 10.000
15 5 Edge Coupled Offset Stripline 1B1A 4 6 3.500 9.000 0.000 99.150 100.000 10.000
16 5 Edge Coupled Offset Stripline 1B1A 4 6 4.500 5.500 0.000 84.480 85.000 10.000
17 5 Edge Coupled Offset Stripline 1B1A 4 6 4.000 5.400 0.000 89.530 90.000 10.000
Impedance Ref. Ref. Trace Trace Strip
Impedance Signal ID Layer Structure Name Plane 1 Plane 2 Width Separation Separation Calculated Target Tol (+/- ID Layer Structure Name in Layer (W1) (S1) (D1) Impedance Impedance %)
18 5 Edge Coupled Offset Stripline 1B1A 4 6 5.000 5.200 0.000 79.440 80.000 10.000
19 12 Offset Stripline 1B1A 11 13 3.600 0.000 0.000 49.450 50.000 10.000
20 12 Offset Stripline 1B1A 11 13 5,400 0,000 0,000 39,750 40,000 10,000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000
21 12 Edge Coupled Offset Stripline 1B1A 11 13 3.500 9.000 0.000 99.150 100.000 10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         9.000         49.840         50.000         10.0000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         99.860         100.000         10.000           28         14         Edge Coup
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         90.000         10.000           28         14         Edge Coupled Offset Stripline 1B1A
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         99.860         100.000         10.000           28         14         Edge Coup

# **4** BOARD FABRICATION SOM EVK MOTHER BOARD

### **Compliance Sheet SOM EVK Mother Board**

- **1.** Country where PCB will be manufactured.
- 2. FAB name where PCB will be manufactured.
- 3. FAB technical capability details are provided (As separate sheets)
- 4. Company where PCB will beAssembled in India

S. No	Description	Specification
Α	PCB FABRICATION	
1	No. of layers	16
2	Via Technology	Through Hole and Blind Via With back drilling option
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40
4	Impedance control (Yes/No) Mention tolerance	Yes
6	Board thickness (1.6mm/2.4mm/3.2mm/ any other) Mention Tolerance Copper finish (35 microns/70 microns/ any other)	Entire board must be: 73.879mil thickness over the laminate 77.579mil thickness over the copper 79.579mil thickness over the Solder mask Copper Thickness: • Outer Layers:
		<ul> <li>a. Signal Layer Thickness 1.85mil</li> <li>Inner Layers:</li> <li>e. Signal Layer Thickness 0.689 ml</li> <li>f. Power (Including ground)</li> <li>layers 0.689 mil and 2.638 mil</li> </ul>
7	Min. finished hole dia (mil)	8 Mil Mech
8	Min. trace width (mil)	3
9	Min. spacing (mil)	3
10	Min. Annular ring (mil)	6

11	Board finish(Hot Air Levelled/ Electroless Ni-Au / Hard Gold / any other)	Enig
12	PCB Dimension in mm	170 mm X 170 mm +/- 10%
13	Metal core board	No
14	Mil Grade	No
15	Whether Group B Test Report required	No
16	Solder Mask Colour	Green
17	Silkscreen Colour	White
18	RoHS Complaint	Yes
19	UL Logo Required	Yes
20	Back Drilling Required	No
21	RF VIAS	No
В	STACKUP REQUIREMENTS	
22	Customer required thickness	73.196+/-7.319 mils Measured:
		Over mask on plated copper
23	Specify Compliance to the Stack up at the	
	bottom	
24	Specify Compliance to the Impedance	
	table at the bottom	
С	table at the bottom       ASSEMBLY	500
С 25	table at the bottomASSEMBLYNo of comps per board	500
С 25 26	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per board	10
C 25 26 27	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin count	10 540, 1 mm LPGA
C 25 26 27 28	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitch	10 540, 1 mm LPGA 0.8 mm
C 25 26 27	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of	10 540, 1 mm LPGA
C 25 26 27 28 29	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)	10           540, 1 mm LPGA           0.8 mm           6000(approx)
C 25 26 27 28 29 30	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pins	10           540, 1 mm LPGA           0.8 mm           6000(approx)           300
C 25 26 27 28 29 30 31	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assembly	10           540, 1 mm LPGA           0.8 mm           6000(approx)           300           Yes
C 25 26 27 28 29 30 31 32	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assemblyBoard Size-	10           540, 1 mm LPGA           0.8 mm           6000(approx)           300           Yes           170 mm X 170 mm +/- 10%
C 25 26 27 28 29 30 31 32 33	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assemblyBoard Size-Board Thickness	10         540, 1 mm LPGA         0.8 mm         6000(approx)         300         Yes         170 mm X 170 mm +/- 10%         79.579 Mils
C 25 26 27 28 29 30 31 32 33 34	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assemblyBoard Size-Board ThicknessNo of Layers	10           540, 1 mm LPGA           0.8 mm           6000(approx)           300           Yes           170 mm X 170 mm +/- 10%
C 25 26 27 28 29 30 31 32 33	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assemblyBoard Size-Board Thickness	10         540, 1 mm LPGA         0.8 mm         6000(approx)         300         Yes         170 mm X 170 mm +/- 10%         79.579 Mils         16
C 25 26 27 28 29 30 31 32 33 34	table at the bottomASSEMBLYNo of comps per boardNo of BGAs per boardMaximum pin countMinimum BGA pitchTotal No of points to be soldered (no of Pins)PTH pinsBoth side assemblyBoard Size-Board ThicknessNo of LayersX-ray verification of all BGA's, LPA and	10         540, 1 mm LPGA         0.8 mm         6000(approx)         300         Yes         170 mm X 170 mm +/- 10%         79.579 Mils         16         Yes. Test results should be

								Isolation			
							Processed	Distance	Copper		
Layer				50	ack up	 Description	Thickness	(Summed)	Coverage	-	Impedance ID
	- 4					Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	
1	- 1	- <b>F</b> _	92_4	<u>_</u>		Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6
	- 1					Isola I-TERA MT40 PP 1086 RC68	3.345	3.345		3.260	
2	- 1					Copper Foil 12 microns	1.850		70.000		
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	-		3.240	
3	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330	7, 8, 9, 10, 11, 12
4	- 1						0.689		75.000		
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
5	- 1			_		Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330	13, 14, 15, 16, 17, 18
6	- 1					Isola I-TEPOK MT40 3 mil Core PVH[1x1078]-VEP2	0.689	3.000	75.000	3.330	
	- 1	li				Isola I-TERA MT40 PP 1035 RC67	1.936	3.873		3.280	
	- 1	1				Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
7	- 1						1.260		75.000		
8						Isola I-TERA MT40 4 mil core 1/2[2x1035]	4.000 2.638	4.000	75.000	3.280	
	79.58	77.58				 Isola I-TERA MT40 PP 1067 RC76	2.340	4.681	10.000	3.080	
		6				 Isola I-TERA MT40 PP 1067 RC76	2.340	-		3.080	
9	- 1						2.638		75.000		
10	- 1					Isola I-TERA MT40 4 mil core 2/1[2x1035]	4.000	4.000	75.000	3.280	
10	- 1					 Isola I-TERA MT40 PP 1035 RC67	1.936	3.873	75.000	3.280	
	- 1					 Isola I-TERA MT40 PP 1035 RC67	1.936	3.673		3.280	
11	- 1					 ISOIA FTERM MINUTE TOSS NOOT	0.689		75.000	3.200	
	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000	3.000		3.330	
12	- 1						0.689		60.000		19, 20, 21, 22, 23, 24
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
13	- 1					Isola I-TERA MT40 PP 1067 RC69	2.176 0.689	-	75.000	3.240	
	- 1					Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000	3.000		3.330	
14	- 1						0.689		60.000		25, 26, 27, 28, 29, 30
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	4.524		3.240	
	- 1					Isola I-TERA MT40 PP 1067 RC69	2.262	-		3.240	
15	- 1					Copper Foil 12 microns	1.850		70.000		
			1	1		Isola I-TERA MT40 PP 1086 RC68	3.345	3.345		3.260	
								Isolation			
							Processed	Distance	Copper		
Layer		_	1		ick up	 Description	Thickness	(Summed)	Coverage	-r3	Impedance ID
16		<b>•</b>	l I	7 6		Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36
						Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	

Cooper Thickness = 20.709 | Dielectric Thickness = 56.869 | Solder Mask Thickness = 2.000 | Stack Up Thickness = 77.579 | Stack Up Thickness with Soldermask = 79.579

Impedance Impedance D         Impedance Signal Layer         Impedance Signal Structure Name         Fer. Plane 1 in Layer         Fer. Plane 2 Width         Fer. Separation (S1)         Ground Separation (S1)         Target Display         Target Target (%)         Target Target (%)         Target Target (%)         Target (%)         Target (%)         Target (%
ID         Löyer         Structure Name         In Layer         (V11)         (S1)         (D1)         Impedance         Impedance         %)           1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         50.080         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.200         0.000         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         89.970         90.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.000         0.000         40.120 <t< td=""></t<>
1         1         Coated Microstrip 1B         2         0         9.400         0.000         40.010         40.000         10.000           2         1         Coated Microstrip 1B         2         0         6.200         0.000         9.000         50.080         50.000         10.000           3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Striphine 1B1A         2         4         5.000         0.000         80.000         80.000         10.000           8         3         Edge Coupled Offset Striphine 1B1A         2
3         1         Edge Coupled Coated Microstrip 1B         2         0         6.500         4.500         0.000         79.440         80.000         10.000           4         1         Edge Coupled Coated Microstrip 1B         2         0         5.600         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
4         1         Edge Coupled Coated Microstrip 1B         2         0         5.500         4.500         0.000         84.630         85.000         10.000           5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
5         1         Edge Coupled Coated Microstrip 1B         2         0         4.800         4.500         0.000         89.970         90.000         10.000           6         1         Edge Coupled Coated Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
6         1         Edge Coupled Costed Microstrip 1B         2         0         4.200         5.700         0.000         99.860         100.000         10.000           7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         80.000         10.000
7         3         Offset Stripline 1B1A         2         4         5.400         0.000         40.120         40.000         10.000           8         3         Edge Coupled Offset Stripline 1B1A         2         4         5.000         5.200         0.000         80.000         10.000
8 3 Edge Coupled Offset Stripline 1B1A 2 4 5.000 5.200 0.000 80.000 80.000 10.000
9 3 Offset Stripline 1B1A 2 4 3.600 0.000 0.000 49.840 50.000 10.000
10 3 Edge Coupled Offset Stripline 1B1A 2 4 3.500 9.000 0.000 99.860 100.000 10.000
11 3 Edge Coupled Offset Stripline 1B1A 2 4 4.500 5.500 0.000 85.050 85.000 10.000
12 3 Edge Coupled Offset Stripline 1B1A 2 4 4.000 5.400 0.000 90.090 90.000 10.000
13 5 Offset Stripline 1B1A 4 6 3.600 0.000 0.000 49.450 50.000 10.000
14 5 Offset Stripline 1B1A 4 6 5.400 0.000 0.000 39.750 40.000 10.000
15 5 Edge Coupled Offset Stripline 1B1A 4 6 3.500 9.000 0.000 99.150 100.000 10.000
16 5 Edge Coupled Offset Stripline 1B1A 4 6 4.500 5.500 0.000 84.480 85.000 10.000
17 5 Edge Coupled Offset Stripline 1B1A 4 6 4.000 5.400 0.000 89.530 90.000 10.000
Impedance Ref. Ref. Trace Trace Strip
Impedance Signal ID Layer Structure Name Plane 1 Plane 2 Width Separation Separation Calculated Target Tol (+/- ID Layer Structure Name in Layer (W1) (S1) (D1) Impedance Impedance %)
18 5 Edge Coupled Offset Stripline 1B1A 4 6 5.000 5.200 0.000 79.440 80.000 10.000
19 12 Offset Stripline 1B1A 11 13 3.600 0.000 0.000 49.450 50.000 10.000
20 12 Offset Stripline 1B1A 11 13 5,400 0,000 0,000 39,750 40,000 10,000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000
21 12 Edge Coupled Offset Stripline 1B1A 11 13 3.500 9.000 0.000 99.150 100.000 10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         100.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         9.000         49.840         50.000         10.0000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         90.860         100.000         10.000           28         14         Edge Coup
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         49.840         50.000         10.000           28         14         Edge Coupl
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         80.000         80.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.600         0.000         90.000         10.000           28         14         Edge Coupled Offset Stripline 1B1A
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         80.000         80.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         99.860         100.000         10.000           28         14
21         12         Edge Coupled Offset Stripline 1B1A         11         13         3.500         9.000         0.000         99.150         100.000         10.000           22         12         Edge Coupled Offset Stripline 1B1A         11         13         4.500         5.500         0.000         84.480         85.000         10.000           23         12         Edge Coupled Offset Stripline 1B1A         11         13         4.000         5.400         0.000         89.530         90.000         10.000           24         12         Edge Coupled Offset Stripline 1B1A         11         13         5.000         5.200         0.000         79.440         80.000         10.000           25         14         Offset Stripline 1B1A         13         15         5.400         0.000         40.120         40.000         10.000           26         14         Edge Coupled Offset Stripline 1B1A         13         15         5.000         5.200         0.000         49.840         50.000         10.000           27         14         Offset Stripline 1B1A         13         15         3.500         9.000         0.000         49.840         50.000         10.000           28         14

### TWO STAGE PAYMENT

Stage 1:40% Payment will be done once the stage 1 is completed and is delivered. Stage 2:60% Payment will be done once the stage 2 is completed and is delivered.

# SIGNATURE OF BIDDER ALONG WITH SEAL OF THE COMPANY WITH DATE

### TECHNICAL BID PROFORMA Tender No. EE/GANT/062/2023/PCBMANASSLY Item Name: PCBs Manufacturing and Assembly

### **1.0 Bidder Eligibility Criteria:**

Ι	Bidder Eligibility Criteria-I (Public Procurement – Preference to Make in India)	Class I / Class II	Local Content Percentage	Ref. Page No.
Ι	Only 'Class-I local suppliers' and 'Class-II local suppliers', as defined under DIPP, MoCI Order No. P-45021/2/2017-PP (BE II) dated 16 <sup>th</sup> September 2020 and other subsequent orders issued therein.			

# **CHECKLIST**

### Please ensure that the following compliance sheets are in your technical bid.

Particulars	Submitted (Yes/No)
Compliance sheet: 1	
Compliance sheet: 2	
Compliance sheet: 3	
Compliance sheet: SOM	
Compliance sheet: Integrated Mother Board	
Compliance sheet: SOM EVK Mother Board	

# <u>The technical details for PCB and assembly are provided below. The BOM for the boards will be</u> providedas Excel sheet upon request. Please email rganti@ee.iitm.ac.in and subashini@5gtbiitm.in

# 2.0 Bidder Eligibility Criteria II:

II	Bidder Eligibility Criteria-II	Complied /Not Complied	Ref Page No.
1	The Firm should have a minimum turnover of 5 crores/year. Evidence should be provided.		
2	The vendor must provide proof of business with other clients (at least 2) in the past year and can provide client references.		
3	The Firm should be in business for a minimum of 5 years. Evidence should be provided.		
4	Please indicate prior High-Speed FPGA and high-power RF boards (of similar complexity of at least 12 layers) that you have fabricated. Vendors without prior experience (of at least two prior boards) of similar complexity will be disqualified. Documentary evidence of the same should be provided.		
5	<ul> <li>Explicitly indicate the PCB Fab details for each board and <u>its</u></li> <li><u>technical capabilities</u>, where each board will be fabricated.</li> <li>References to online material/documentation for verification <u>should</u></li> <li>be provided. The bid might be disqualified if the technical</li> <li>capabilities of the proposed FAB are not clear or do notmeet the</li> <li>technical requirements of the boards.</li> <li>1. The country of the FAB should explicitly be mentioned.</li> <li>a. If these boards are manufactured in countries that sharea</li> </ul>		
	<ul> <li>In these bounds are manufactured in countries that shared land border with India, the bid will be eligible only if the FAB is registered with the competent authority and the required approvals are obtained as mentioned in the GFR amendments (<u>Rule 144 (xi)</u>) posted on 23<sup>rd</sup> July 2020.</li> <li>b. These required approvals have to be part of the technical tender for the bid to be valid.</li> </ul>		
6	<ul> <li>Prior engineering compliance with the FAB (for meeting the technical specifications, as mentioned in the subsequent sections) for manufacturing the required PCB should be provided (for each PCB) in the templates provided in the next sections.</li> <li>1. The confirmation from the FAB (as email exchange or letters (in English)) should also be provided in the tender.</li> <li>2. Some important considerations</li> <li>Most of the boards require blind vias.</li> <li>Impedance control is required</li> </ul>		

7	Explicitly indicate the plant details <b>and its technical capabilities</b> , where the board will be assembled.	
8	<ul> <li>Please indicate the country of the assembly facility. The assembly facility should be in India.</li> <li>Where IITM can ship the required components (FPGA's, ICs, Transceivers)</li> <li>The assembly plant and testing facility should be in India and should be ready for rework as the case arises without additional cost</li> </ul>	
9	• Support for double-sided PCB assembly Assembly should have the capability of IPC-610 class2 and class 3 standards	
10	The assembly line should be capable of handling 01005 discrete components, 0.4 mm BGA's, 0.4 mm pitch, LGA CC-20-3, and should have the capability of odd angle placement	
11	Assembly Should have the facility for flying probe testers and automated optical lines (inspection)	
12	Assembly should have in house X-ray inspection should be available	

## **3.0 Technical Compliance**:

# 1) Technical Specifications, quantities for compliance

The following boards are going to be manufactured. All the boards have two stages of manufacturing.

Stage1: PCB fab and assembly for X no of boards. The exact numbers for assembled and bare boards are provided below.

Stage 2: PCB fab and assembly for Y no of boards. The exact numbers for assembled are provided below.

S No	Board name	(	Quantity for Sta	ge 1	Quantity for Stage 2	Total
S. No	boaru name	Bare Board	Power & Clock Board	Full Assembly	Full Assembly	Quantity
1	SOM	1	1	4	14	20
2	Integrated Mother Board	1	0	2	4	7
3	SOM EVK Mother Board	1	0	2	4	7

\*There will be minor design changes between Stage 1 and Stage 2.

# **Compliance Sheet 1**

S. No		Complied/ Not Complied
1	There may be design changes in the PCBs (schematics and layout) between Stage 1 and Stage 2. Also a few components (around 5%)might change based on the outcomes of each stage. The Vendor should be able to accommodate these.	
2	Open, Short, and Impedance reports must be submitted before and after Assembly to IIT Madras for validation of the quality of Fabrication and Assembly for 1 st Stage. (Exact Test points Will be shared along with Gerbers)	
3	Complete Test Procedure with detailed Steps will be shared for the 2nd Stage, In addition to Open Short and Impedance testing this includes: 1. Power On test 2. Clock Programming 3. Booting	
4	IIT Madras only will be paying for boards that have passed the tests and been approved and validated by IITM	

# **Compliance sheet 2**

S. No			Complied/Not Complied
1	Turnaround time from the receipt of the PO tillthe fabrication and assembly of the boards for	8 Weeks	
	Stage 1		
2	Turnaround time from the receipt of the go ahead till the fabrication and assembly of the boards for Stage 2	8 weeks	

# Terms and conditions.

# **Compliance sheet 3**

S. No		Complied/Not Complied
1	The delivery time cannot be changed	
2	All the boards have been quoted. If some boards are not quoted the vendor will be dis-qualified	
3	<ul> <li>The stack up, PCB pre-peg and Core materials of the boards, the via and Trace dimensions and any technical specifications of these boards were designed after extensivesimulations and will be impossible to change.</li> <li>Attached Stack-up has been verified by the following Fabricators: <ol> <li><u>HiQ</u></li> <li><u>Phase-3</u></li> <li>Micro-pack</li> </ol> </li> </ul>	

	We encourage the bidders to Fabricate boards from the above Vendors for quick turnaround time. But, bidders are allowed to Fabricate with any other reputed Vendor(as per the tender clauses) as along as the Stack-up and Timeline remains same.	
4	Basic rework might be requested (as required) and the vendor should support this without any additional cost	
5	PCB fabrication: At the end of Stage1, the firm should provide us with a report on the PCBs that were fabricated and assembled and proceed with the assembly only after technical approval by the IITM team.	
6	In the financial bid, the fabrication cost of each PCB, BOM cost, and Assembly cost are separately and explicitly mentioned.	
7	Will provide the BOM as per the requirements for all the boards. <u>The BOM for the boards will be</u> provided as excel sheet upon request. Please email rganti@ee.iitm.ac.in and subashini@5gtbiitm.in. Part of the BOM for assembly will be provided by IIT-Madras.	
8	BOM supplied by the Vendor should have warranty and COC certification	

# **2 BOARD FABRICATION SOM**

# **Compliance Sheet SOM**

S. No		Details
1	Country where PCB will bemanufactured	
2	FAB name where PCB will bemanufactured.	
3	FAB technical capability details are provided (As separate sheets)	
4	Company where PCB will beAssembled in India	

S. No	Description	Specification	Complied/Not Complied
Α	PCB FABRICATION		
1	No. of layers	16	
2	Via Technology	Through Hole and Blind Via With back drilling option	
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40	
4	Impedance control (Yes/No) Mention tolerance	Yes	
5	Board thickness	Entire board must be:	
	(1.6mm/2.4mm/3.2mm/ any other) Mention Tolerance	69.496mil thickness over the laminate 73.196mil thickness over the copper 75.196mil thickness over the Solder mask	
6	Copper finish (35 microns/70 microns/ any other)	<ul> <li>Copper Thickness:</li> <li>Outer Layers: <ul> <li>a. Signal Layer Thickness 1.85mil</li> <li>Inner Layers:</li> <li>g. Signal Layer Thickness 0.689 ml</li> <li>h. Power (Including ground)</li> <li>layers 0.689 mil and 2.638 mil</li> </ul> </li> </ul>	
7	Min. finished hole dia (mil)	8 Mil Mech	
8	Min. trace width (mil)	3	
9	Min. spacing (mil)	3	
10	Min. Annular ring (mil)	6	

11	Board finish(Hot Air Levelled/ Electroless Ni-Au / Hard Gold / any other)	Enig	
12	PCB Dimension in mm	125 mm X 90 mm +/- 10%	
13	Metal core board	No	
14	Mil Grade	No	
15	Whether Group B Test Report required	No	
16	Solder Mask Colour	Green	
17	Silkscreen Colour	White	
18	RoHS Complaint	Yes	
19	UL Logo Required	Yes	
20	Back Drilling Required	No	
21	RF VIAS	No	
В	STACKUP REQUIREMENTS		
22	Customer required thickness	73.196+/-7.319 mils Measured:	
		Over mask on plated copper	
23	Specify Compliance to the Stack up at the		
	bottom		
24	Specify Compliance to the Impedance		
	table at the bottom		
С	ASSEMBLY		
25	No of comps per board	1000	
26	No of BGAs per board	10	
27	Maximum pin count	1516, 1 mm BGA	
28	Minimum BGA pitch	1 mm	
29	Total No of points to be soldered (no of Pins)	6000(approx)	
30	PTH pins	300	
31	Both side assembly	Yes	
32	Board Size-	125 mm X 90 mm+/- 10%	
33	Board Thickness	75.196 Mils	
34	No of Layers	16	
35	X-ray verification of all BGA's, LPA and	Yes. Test results should be	
	QFN	provided.	
36	QFN AOI report for the components	Yes, Report needed	

	-							_				
									Isolation	-		
Laver					Star	* up	Description	Processed Thickness		Copper Coverage	εr	Impedance ID
- Cayes		_	_	_	otac	w ob	 • •		T (oaninea)	Coverage		impedance io
				1.0			Taiyo PSR 4000 HFX DI-GREEN	1.000		100 000	3.500	
1		↑		-41			Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6
			9 E				Isola I-TERA MT40 PP 1086 RC68	3.345	3.345		3.260	
2							 Copper Foil 12 microns	1.850		70.000		
							 Isola I-TERA MT40 PP 1067 RC69	2.262	4.524		3.240	
			4				Isola I-TERA MT40 PP 1067 RC69	2.262	-		3.240	
3				-11			Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330	7, 8, 9, 10, 11, 12
4								0.689		75.000		
							Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
							Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
5				_				0.689		60.000		13, 14, 15, 16, 17, 18
6							 Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	75.000	3.330	
			7 E	= 1			 Isola I-TERA MT40 PP 1035 RC67	1.936	3.873		3.280	
				= 1	_		 Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
7								1.260		75.000		
	-						Isola I-TERA MT40 4 mil core 1/2[2x1035]	4.000	4.000		3.280	
8	79.58	32						2.638		75.000		
	-	Ē					 Isola I-TERA MT40 PP 1067 RC76	2.340	4.681		3.080	
9							 Isola I-TERA MT40 PP 1067 RC76	2.340 2.638	-	75.000	3.080	
9				- 1			 Isola I-TERA MT40 4 mil core 2/1[2x1035]	4.000	4.000	75.000	3.280	
10								1.260		75.000		
							Isola I-TERA MT40 PP 1035 RC67	1.936	3.873		3.280	
							Isola I-TERA MT40 PP 1035 RC67	1.936	-		3.280	
11								0.689		75.000	3.330	
12							Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	60.000	3.330	19, 20, 21, 22, 23, 24
							Isola I-TERA MT40 PP 1067 RC69	2.176	4.352		3.240	
			36				Isola I-TERA MT40 PP 1067 RC69	2.176	-		3.240	
13								0.689		75.000		
14						_	Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000	3.000	60.000	3.330	25, 26, 27, 28, 29, 30
14				-11			Isola I-TERA MT40 PP 1067 RC69	2.262	4.524	60.000	3.240	25, 26, 27, 28, 29, 30
				- 1			 Isola I-TERA MT40 PP 1067 RC69	2.262	4.024		3.240	
15			3 E					1.850	-	70.000	3.240	
10							Copper Foil 12 microns Isola I-TERA MT40 PP 1086 RC68	3.345	3.345	70.000	3.260	
		<u> </u>		11			 15013 FTERON MT40 PP 1086 RC68	3.345	3.345		3.260	
									Isolation			
							Description	Processed	Distance	Copper		land and the
Layer	-	_	-1-		Stack		Description	Thickness	(Summed)	Coverage	13	Impedance ID
16		. <b>.</b>		U			Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36
		, I					Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500	
							Connect Thislance - 20,200   Distantis Thislance		day March Thi		0.0 10-	ck Up Thickness = 72 570   Stack Up Thickness with Soldermark = 70 570

Cooper Thickness = 20.709 | Dielectric Thickness = 56.869 | Solder Mask Thickness = 2.000 |Stack Up Thickness = 77.579 | Stack Up Thickness with Soldermask = 79.579

Impedance	Impedance Signal		Ref. Plane 1	Ref. Plane 2	Lower Trace Width	Trace Separation	Ground Strip Separation	Calculated	Target	Tol (+/-
ID	Layer	Structure Name	in Layer	in Layer	(W1)	(S1)	(D1)	Impedance	Impedance	%)
1	1	Coated Microstrip 1B	2	0	9.400	0.000	0.000	40.010	40.000	10.000
2	1	Coated Microstrip 1B	2	0	6.200	0.000	0.000	50.080	50.000	10.000
3	1	Edge Coupled Coated Microstrip 1B	2	0	6.500	4.500	0.000	79.440	80.000	10.000
4	1	Edge Coupled Coated Microstrip 1B	2	0	5.600	4.500	0.000	84.630	85.000	10.000
5	1	Edge Coupled Coated Microstrip 1B	2	0	4.800	4.500	0.000	89.970	90.000	10.000
6	1	Edge Coupled Coated Microstrip 1B	2	0	4.200	5.700	0.000	99.860	100.000	10.000
7	3	Offset Stripline 1B1A	2	4	5.400	0.000	0.000	40.120	40.000	10.000
8	3	Edge Coupled Offset Stripline 1B1A	2	4	5.000	5.200	0.000	80.000	80.000	10.000
9	3	Offset Stripline 1B1A	2	4	3.600	0.000	0.000	49.840	50.000	10.000
10	3	Edge Coupled Offset Stripline 1B1A	2	4	3.500	9.000	0.000	99.860	100.000	10.000
11	3	Edge Coupled Offset Stripline 1B1A	2	4	4.500	5.500	0.000	85.050	85.000	10.000
12	3	Edge Coupled Offset Stripline 1B1A	2	4	4.000	5.400	0.000	90.090	90.000	10.000
13	5	Offset Stripline 1B1A	4	6	3.600	0.000	0.000	49.450	50.000	10.000
14	5	Offset Stripline 1B1A	4	6	5.400	0.000	0.000	39.750	40.000	10.000
15	5	Edge Coupled Offset Stripline 1B1A	4	6	3.500	9.000	0.000	99.150	100.000	10.000
16	5	Edge Coupled Offset Stripline 1B1A	4	6	4.500	5.500	0.000	84.480	85.000	10.000
17	5	Edge Coupled Offset Stripline 1B1A	4	6	4.000	5.400	0.000	89.530	90.000	10.000

					1		Count			
	Impedance		Ref.	Ref.	Lower Trace	Trace	Ground Strip			
Impedance ID	Signal Laver	Structure Name	Plane 1 in Laver	Plane 2 in Layer	Width (W1)	Separation (S1)	Separation (D1)	Calculated Impedance	Target Impedance	Tol (+/- %)
					5.000	5,200	0.000	79.440	80.000	10.000
18	5	Edge Coupled Offset Stripline 1B1A	4	6	5.000	5.200	0.000	79.440	80.000	10.000
19	12	Offset Stripline 1B1A	11	13	3.600	0.000	0.000	49.450	50.000	10.000
20	12	Offset Stripline 1B1A	11	13	5.400	0.000	0.000	39.750	40.000	10.000
21	12	Edge Coupled Offset Stripline 1B1A	11	13	3.500	9.000	0.000	99.150	100.000	10.000
22	12	Edge Coupled Offset Stripline 1B1A	11	13	4.500	5.500	0.000	84.480	85.000	10.000
23	12	Edge Coupled Offset Stripline 1B1A	11	13	4.000	5,400	0.000	89.530	90.000	10.000
24	12	Edge Coupled Offset Stripline 1B1A	11	13	5.000	5.200	0.000	79.440	80.000	10.000
25	14	Offset Stripline 1B1A	13	15	5.400	0.000	0.000	40.120	40.000	10.000
26	14	Edge Coupled Offset Stripline 1B1A	13	15	5.000	5,200	0.000	80.000	80.000	10.000
20	14	Edge Coupled Oliset Scipline TBTA	13	15	5.000	5.200	0.000		80.000	
27	14	Offset Stripline 1B1A	13	15	3.600	0.000	0.000	49.840	50.000	10.000
28	14	Edge Coupled Offset Stripline 1B1A	13	15	3.500	9.000	0.000	99.860	100.000	10.000
			40			5 500	0.000	05.050	05.000	
29	14	Edge Coupled Offset Stripline 1B1A	13	15	4.500	5.500	0.000	85.050	85.000	10.000
30	14	Edge Coupled Offset Stripline 1B1A	13	15	4.000	5.400	0.000	90.090	90.000	10.000
31	16	Coated Microstrip 1B	15	0	9.400	0.000	0.000	40.010	40.000	10.000
32	16	Coated Microstrip 1B	15	0	6.200	0.000	0.000	50.080	50.000	10.000
33	16	Edge Coupled Coated Microstrip 1B	15	0	6.500	4.500	0.000	79.440	80.000	10.000
34	16	Edge Coupled Coated Microstrip 1B	15	0	5.600	4.500	0.000	84.630	85.000	10.000
35	16	Edge Coupled Coated Microstrip 1B	15	0	4.800	4.500	0.000	89.970	90.000	10.000
36	16	Edge Coupled Coated Microstrip 1B	15	0	4.200	5,700	0.000	99,860	100.000	10.000
		-								

# **3 BOARD FABRICATION INTEGRATED MOTHER BOARD**

**Compliance Sheet SOM** 

S. No		Details
1	Country where PCB will bemanufactured	
2	FAB name where PCB will bemanufactured.	
3	FAB technical capability details are provided (As separate sheets)	
4	Company where PCB will beAssembled in India	

S. No	Description	Specification	Complied/Not Complied
А	PCB FABRICATION		
1	No. of layers	16	
2	Via Technology	Through Hole and Blind Via With back drilling option	
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40	
4	Impedance control (Yes/No) Mention tolerance	Yes	
5	Board thickness	Entire board must be:	
	(1.6mm/2.4mm/3.2mm/ any other) Mention Tolerance	69.496mil thickness over the laminate 73.196mil thickness over the copper 75.196mil thickness over the Solder mask	
6	Copper finish (35 microns/70 microns/ any other)	<ul> <li>Copper Thickness:</li> <li>Outer Layers: <ul> <li>a. Signal Layer Thickness 1.85mil</li> <li>Inner Layers:</li> <li>i. Signal Layer Thickness 0.689 ml</li> <li>j. Power (Including ground)</li> <li>layers 0.689 mil and 2.638 mil</li> </ul> </li> </ul>	
7	Min. finished hole dia (mil)	8 Mil Mech	
8	Min. trace width (mil)	3	
9	Min. spacing (mil)	3	
10	Min. Annular ring (mil)	6	

11	Board finish(Hot Air Levelled/ Electroless Ni-Au / Hard Gold / any other)	Enig	
12	PCB Dimension in mm	125 mm X 90 mm +/- 10%	
13	Metal core board	No	
14	Mil Grade	No	
15	Whether Group B Test Report required	No	
16	Solder Mask Colour	Green	
17	Silkscreen Colour	White	
18	RoHS Complaint	Yes	
19	UL Logo Required	Yes	
20	Blind Vias Buried Vias Back Drilling Required	Yes	
21	RFVIAS	No	
В	STACKUP REQUIREMENTS		
22	Customer required thickness	73.196+/-7.319 mils Measured:	
		Over mask on plated copper	
23	Specify Compliance to the Stack up at the bottom		
24	Specify Compliance to the Impedance		
	table at the bottom		
С	ASSEMBLY		
25	No of comps per board	500	
26	No of BGAs per board	10	
27	Maximum pin count	540, 1 mm LPGA	
28	Minimum BGA pitch	0.8 mm	
29	Total No of points to be soldered (no of	6000(approx)	
	Pins)		
30	PTH pins	300	
31	Both side assembly	Yes	
32	Board Size-	450 mm X 400 mm+/- 10%	
33	Board Thickness	75.196 Mils	
34	No of Layers	16	
35	X-ray verification of all BGA's, LPA and	Yes. Test results should be	
	QFN	provided.	
36	AOI report for the components	Yes, Report needed	
37	Manual Inspection of Q&A for all I. C's	Yes, Report needed	

						leeletie -				
					Processed	Isolation Distance	Copper			
Layer			Stack up	Description	Thickness	(Summed)	Coverage	εr	Impedance ID	
	•			Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500		
1		두 🌗 🧍		Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6	
				Isola I-TERA MT40 PP 1080 RC70	3.324	3.324		3.210		
2				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330		
3					0.689	0.000	40.000	0.000	7, 8, 9, 10, 11, 12	
			and the second se	Isola I-TERA MT40 PP 1035 RC67	1.890	4.491		3.280		
				Isola I-TERA MT40 PP 1067 RC76	2.601	•		3.080		
4				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330		
5					0.689	0.000	40.000	0.000	13, 14, 15, 16, 17, 18	
				Isola I-TERA MT40 PP 1035 RC67	1.890	4.491		3.280		
				Isola I-TERA MT40 PP 1067 RC76	2.601	-		3.080		
6				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330		
7					0.689	0.000	60.000	0.000		
				Isola I-TERA MT40 PP 1067 RC76	2.335	4.669		3.080		
				Isola I-TERA MT40 PP 1067 RC76	2.335	-		3.080		
8	75.20			Isola I-TERA MT40 4 mil core 2/2[2x1035]-VLP2	2.638 4.000	4.000	60.000	3.280		
9	1 2	2			2.638	4.000	60.000			
				Isola I-TERA MT40 PP 1067 RC76	2.335	4.669		3.080		
				Isola I-TERA MT40 PP 1067 RC76	2.335	-		3.080		
10				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	60.000	3.330		
11					0.689	0.000	60.000	0.000		
				Isola I-TERA MT40 PP 1067 RC76	2.601	4.491		3.080		
				Isola I-TERA MT40 PP 1035 RC67	1.890	÷		3.280		
12				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	40.000	3.330	19, 20, 21, 22, 23, 24	
13					0.689		60.000			
				Isola I-TERA MT40 PP 1067 RC76	2.601	4.491		3.080		
				Isola I-TERA MT40 PP 1035 RC67	1.890	-		3.280		
14				Isola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	40.000	3.330	25, 26, 27, 28, 29, 30	
15					0.689		60.000			
				Isola I-TERA MT40 PP 1080 RC70	3.324	3.324		3.210		
16				Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36	
						Isolation				
					Processed	Distance	Copper			
Layer			Stack up	Description	Thickness	(Summed)	Coverage	٦3	Impedance ID	
	•			Taiyo PSR 4000 HFX DI-GREEN	1.000			3.500		

 Talyo PSR 4000 HFX DI-GREEN
 1.000
 3.500

 Copper Thickness = 17.245 | Dielectric Thickness = 55.951 | Solder Mask Thickness = 2.000 | Stack Up Thickness = 73.196 | Stack Up Thickness with Soldermask = 75.196

					Lower		Ground			
Impedance	Impedance Signal		Ref. Plane 1	Ref. Plane 2	Trace Width	Trace Separation	Strip Separation	Calculated	Target	Tol (+/-
ID	Layer	Structure Name	in Layer	in Layer	(W1)	(S1)	(D1)	Impedance	Impedance	%)
1	1	Coated Microstrip 1B	2	0	9.400	0.000	0.000	40.100	40.000	10.000
2	1	Coated Microstrip 1B	2	0	6.250	0.000	0.000	50.000	50.000	10.000
3	1	Edge Coupled Coated Microstrip 1B	2	0	6.500	4.500	0.000	79.640	80.000	10.000
4	1	Edge Coupled Coated Microstrip 1B	2	0	5.600	4.500	0.000	84.850	85.000	10.000
5	1	Edge Coupled Coated Microstrip 1B	2	0	4.800	4.500	0.000	90.200	90.000	10.000
6	1	Edge Coupled Coated Microstrip 1B	2	0	4.200	5.700	0.000	100.120	100.000	10.000
7	3	Edge Coupled Offset Stripline 1B2A	2	4	5.000	5.200	0.000	80.000	80.000	10.000
8	3	Offset Stripline 1B2A	2	4	5.400	0.000	0.000	40.120	40.000	10.000
9	3	Offset Stripline 1B2A	2	4	3.600	0.000	0.000	49.810	50.000	10.000
10	3	Edge Coupled Offset Stripline 1B2A	2	4	3.500	9.000	0.000	99.770	100.000	10.000
11	3	Edge Coupled Offset Stripline 1B2A	2	4	4.500	5.500	0.000	85.040	85.000	10.000
12	3	Edge Coupled Offset Stripline 1B2A	2	4	4.000	5.400	0.000	90.070	90.000	10.000
13	5	Offset Stripline 1B2A	4	6	5.400	0.000	0.000	40.120	40.000	10.000
14	5	Offset Stripline 1B2A	4	6	3.600	0.000	0.000	49.810	50.000	10.000
15	5	Edge Coupled Offset Stripline 1B2A	4	6	3.500	9.000	0.000	99.770	100.000	10.000
16	5	Edge Coupled Offset Stripline 1B2A	4	6	4.500	5.500	0.000	85.040	85.000	10.000
17	5	Edge Coupled Offset Stripline 1B2A	4	6	4.000	5.400	0.000	90.070	90.000	10.000
18	5	Edge Coupled Offset Stripline 1B2A	4	6	5.000	5.200	0.000	80.000	80.000	10.000

Impedance	Impedance Signal		Ref. Plane 1	Ref. Plane 2	Lower Trace Width	Trace Separation	Ground Strip Separation	Calculated	Target	Tol (+/-
Inpedance	Layer	Structure Name	in Layer	in Layer	(W1)	(S1)	(D1)	Impedance	Impedance	%)
19	12	Offset Stripline 1B2A	11	13	5.400	0.000	0.000	40.120	40.000	10.000
20	12	Offset Stripline 1B2A	11	13	3.600	0.000	0.000	49.810	50.000	10.000
21	12	Edge Coupled Offset Stripline 1B2A	11	13	3.500	9.000	0.000	99.770	100.000	10.000
22	12	Edge Coupled Offset Stripline 1B2A	11	13	4.500	5.500	0.000	85.040	85.000	10.000
23	12	Edge Coupled Offset Stripline 1B2A	11	13	4.000	5.400	0.000	90.070	90.000	10.000
24	12	Edge Coupled Offset Stripline 1B2A	11	13	5.000	5.200	0.000	80.000	80.000	10.000
25	14	Edge Coupled Offset Stripline 1B2A	13	15	5.000	5.200	0.000	80.000	80.000	10.000
26	14	Offset Stripline 1B2A	13	15	5.400	0.000	0.000	40.120	40.000	10.000
27	14	Offset Stripline 1B2A	13	15	3.600	0.000	0.000	49.810	50.000	10.000
28	14	Edge Coupled Offset Stripline 1B2A	13	15	3.500	9.000	0.000	99.770	100.000	10.000
29	14	Edge Coupled Offset Stripline 1B2A	13	15	4.500	5.500	0.000	85.040	85.000	10.000
30	14	Edge Coupled Offset Stripline 1B2A	13	15	4.000	5.400	0.000	90.070	90.000	10.000
31	16	Coated Microstrip 1B	15	0	9.400	0.000	0.000	40.100	40.000	10.000
32	16	Coated Microstrip 1B	15	0	6.250	0.000	0.000	50.000	50.000	10.000
33	16	Edge Coupled Coated Microstrip 1B	15	0	6.500	4.500	0.000	79.640	80.000	10.000
34	16	Edge Coupled Coated Microstrip 1B	15	0	5.600	4.500	0.000	84.850	85.000	10.000
35	16	Edge Coupled Coated Microstrip 1B	15	0	4.800	4.500	0.000	90.200	90.000	10.000
36	16	Edge Coupled Coated Microstrip 1B	15	0	4.200	5.700	0.000	100.120	100.000	10.000

# **4 BOARD FABRICATION SOM EVK MOTHER BOARD**

# **Compliance Sheet SOM EVK Mother Board**

S. No		Details
1	Country where PCB will bemanufactured	
2	FAB name where PCB will bemanufactured.	
3	FAB technical capability details areprovided (As separate sheets)	
4	Company where PCB will beAssembled in India	

S. No	Description	Specification	Complied/Not Complied
Α	PCB FABRICATION		•
1	No. of layers	16	
2	Via Technology	Through Hole and Blind Via With back drilling option	
3	Material (Specify clearly whether High Tg or Normal Tg)	Isola I-TERA MT40	
4	Impedance control (Yes/No) Mention tolerance	Yes	
6	Board thickness (1.6mm/2.4mm/3.2mm/ any other) Mention Tolerance Copper finish (35 microns/70 microns/ any other)	<ul> <li>Entire board must be:</li> <li>69.496mil thickness over the</li> <li>laminate</li> <li>73.196mil thickness over the</li> <li>copper</li> <li>75.196mil thickness over the</li> <li>Solder mask</li> <li>Copper Thickness:</li> <li>Outer Layers: <ul> <li>a. Signal Layer Thickness 1.85mil</li> <li>Inner Layers:</li> <li>k. Signal Layer Thickness 0.689 ml</li> <li>I. Power (Including ground)</li> <li>layers 0.689 mil and 2.638 mil</li> </ul> </li> </ul>	
7	Min. finished hole dia (mil)	8 Mil Mech	
8	Min. trace width ( mil )	3	
9	Min. spacing (mil)	3	
10	Min. Annular ring (mil)	6	

11	Board finish(Hot Air Levelled/ Electroless	Enig	
	Ni-Au / Hard Gold / any other)		
12	PCB Dimension in mm	170 mm X 170 mm	
		+/- 10%	
13	Metal core board	No	
14	Mil Grade	No	
15	Whether Group B Test Report required	No	
16	Solder Mask Colour	Green	
17	Silkscreen Colour	White	
18	RoHS Complaint	Yes	
19	UL Logo Required	Yes	
20	Back Drilling Required	No	
21	RF VIAS	No	
В	STACKUP REQUIREMENTS		
22	Customer required thickness	73.196+/-7.319 mils	
		Measured:	
		Over mask on plated	
23	Specify Compliance to the Stack up at the	copper	
25	bottom		
24	Specify Compliance to the Impedance		
	table at the bottom		
С	ASSEMBLY		
25	No of comps per board	500	
26	No of BGAs per board	10	
27	Maximum pin count	540, 1 mm LPGA	
28	Minimum BGA pitch	0.8 mm	
29	Total No of points to be soldered (no of	6000(approx)	
	Pins)		
30	PTH pins	300	
31	Both side assembly	Yes	
32	Board Size-	170 mm X 170 mm	
		+/- 10%	
33	Board Thickness	75.196 Mils	
0.1	No of Louis	16	
34	No of Layers	10	
34 35	X-ray verification of all BGA's, LPA and	Yes. Test results	
		Yes. Test results should be	
35	X-ray verification of all BGA's, LPA and QFN	Yes. Test results should be provided.	
	X-ray verification of all BGA's, LPA and	Yes. Test results should be	

			Processed	Isolation Distance	Copper		
Layer	Stack up	Description	Thickness	(Summed)	Coverage	εr	Impedance ID
	T	aiyo PSR 4000 HFX DI-GREEN	1.000			3.500	
1		Copper Foil 12 microns	1.850		100.000		1, 2, 3, 4, 5, 6
	Is	sola I-TERA MT40 PP 1080 RC70	3.324	3.324		3.210	
2			0.689		60.000		
3		sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	40.000	3.330	7, 8, 9, 10, 11, 12
		sola I-TERA MT40 PP 1035 RC67	1.890	4.491	10.000	3.280	
		sola I-TERA MT40 PP 1067 RC76	2.601	-		3.080	
4			0.689		60.000		
E		sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	40.000	3.330	13, 14, 15, 16, 17, 18
5		sola I-TERA MT40 PP 1035 RC67	1.890	4.491	40.000	3.280	13, 14, 13, 10, 17, 18
		sola I-TERA MT40 PP 1067 RC76	2.601			3.080	
6			0.689		60.000	0.000	
	Is and Is and Is	sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000 0.689	3.000	60.000	3.330	
/		sola I-TERA MT40 PP 1067 RC76	2.335	4.669	60.000	3.080	
		sola I-TERA MT40 PP 1067 RC76	2.335	4.009		3.080	
8	• •		2.638	-	60.000	3.000	
	75.2 1 1	sola I-TERA MT40 4 mil core 2/2[2x1035]-VLP2	4.000	4.000		3.280	
9			2.638	4 000	60.000		
		sola I-TERA MT40 PP 1067 RC76 sola I-TERA MT40 PP 1067 RC76	2.335	4.669		3.080 3.080	
10		sola FTERA M140 PP 1067 RC76	0.689		60.000	3.080	
	list list	sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	3.000	3.000		3.330	
11			0.689		60.000		
		sola I-TERA MT40 PP 1067 RC76	2.601	4.491		3.080	
		sola I-TERA MT40 PP 1035 RC67	1.890	•		3.280	
12		sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	40.000	3.330	19, 20, 21, 22, 23, 24
13			0.689		60.000		
		sola I-TERA MT40 PP 1067 RC76	2.601	4.491		3.080	
	Is	sola I-TERA MT40 PP 1035 RC67	1.890	-		3.280	
14		sola I-TERA MT40 3 mil core H/H[1x1078]-VLP2	0.689 3.000	3.000	40.000	3.330	25, 26, 27, 28, 29, 30
15			0.689		60.000	0.000	
	ls ls	sola I-TERA MT40 PP 1080 RC70	3.324	3.324		3.210	
16		Copper Foil 12 microns	1.850		100.000		31, 32, 33, 34, 35, 36
			Processed	Isolation Distance	Copper		
Layer	Stack up	Description	Thickness	(Summed)	Coverage	εr	Impedance ID
			1 000			0.500	

 Processed
 Distance
 Copper

 Thickness
 (Summed)
 Coverage
 εr
 Impedance ID

 1.000
 3.500

V

 Description
 Copper Thickness
 Copper (Summed)
 Coverage Coverage
 cr
 Impedance ID

 Taiyo PSR 4000 HFX DI-GREEN
 1.000
 3.500
 3.500

 Copper Thickness = 17.245
 Dielectric Thickness = 55.951
 Solder Mask Thickness = 2.000
 [Stack Up Thickness = 73.196]
 Stack Up Thickness with Soldermask = 75.196

					Lower		Ground			
	Impedance		Ref.	Ref.	Trace	Trace	Strip			
Impedance ID	Signal Layer	Structure Name	Plane 1 in Laver	Plane 2 in Layer	Width (W1)	Separation (S1)	Separation (D1)	Calculated Impedance	Target Impedance	Tol (+/- %)
1	1	Coated Microstrip 1B	2	0	9.400	0.000	0.000	40.100	40.000	10.000
2		Coated Microstrip 1B	2	0	6.250	0.000	0.000	50.000	50.000	10.000
2	1	Coated Microstrip 18	2	U	0.250	0.000	0.000	50.000	50.000	
3	1	Edge Coupled Coated Microstrip 1B	2	0	6.500	4.500	0.000	79.640	80.000	10.000
4	1	Edge Coupled Coated Microstrip 1B	2	0	5.600	4.500	0.000	84.850	85.000	10.000
5	1	Edge Coupled Coated Microstrip 1B	2	0	4.800	4.500	0.000	90.200	90.000	10.000
					4.200	5,700	0.000	100.120	100.000	10.000
6	1	Edge Coupled Coated Microstrip 1B	2	0	4.200		0.000	100.120	100.000	
7	3	Edge Coupled Offset Stripline 1B2A	2	4	5.000	5.200	0.000	80.000	80.000	10.000
8	3	Offset Stripline 1B2A	2	4	5.400	0.000	0.000	40.120	40.000	10.000
9	3	Offset Stripline 1B2A	2	4	3.600	0.000	0.000	49.810	50.000	10.000
10	3	Edge Coupled Offset Stripline 1B2A	2	4	3.500	9.000	0.000	99.770	100.000	10.000
11	3	Edge Coupled Offset Stripline 1B2A	2	4	4.500	5.500	0.000	85.040	85.000	10.000
12	3	Edge Coupled Offset Stripline 1B2A	2	4	4.000	5.400	0.000	90.070	90.000	10.000
13	5	Offset Stripline 1B2A	4	6	5.400	0.000	0.000	40.120	40.000	10.000
14	5	Offset Stripline 1B2A	4	6	3.600	0.000	0.000	49.810	50.000	10.000
15	5	Edge Coupled Offset Stripline 1B2A	4	6	3.500	9.000	0.000	99.770	100.000	10.000
16	5	Edge Coupled Offset Stripline 1B2A	4	6	4.500	5.500	0.000	85.040	85.000	10.000
17	5	Edge Coupled Offset Stripline 1B2A	4	6	4.000	5.400	0.000	90.070	90.000	10.000
18	5	Edge Coupled Offset Stripline 1B2A	4	6	5.000	5.200	0.000	80.000	80.000	10.000

Impedance	Impedance Signal		Ref. Plane 1	Ref. Plane 2	Lower Trace Width	Trace Separation	Ground Strip Separation	Calculated	Target	Tol (+/-
Impedance	Layer	Structure Name	in Layer	in Layer	(W1)	(S1)	(D1)	Impedance	Impedance	%)
19	12	Offset Stripline 1B2A	11	13	5.400	0.000	0.000	40.120	40.000	10.000
20	12	Offset Stripline 1B2A	11	13	3.600	0.000	0.000	49.810	50.000	10.000
21	12	Edge Coupled Offset Stripline 1B2A	11	13	3.500	9.000	0.000	99.770	100.000	10.000
22	12	Edge Coupled Offset Stripline 1B2A	11	13	4.500	5.500	0.000	85.040	85.000	10.000
23	12	Edge Coupled Offset Stripline 1B2A	11	13	4.000	5.400	0.000	90.070	90.000	10.000
24	12	Edge Coupled Offset Stripline 1B2A	11	13	5.000	5.200	0.000	80.000	80.000	10.000
25	14	Edge Coupled Offset Stripline 1B2A	13	15	5.000	5.200	0.000	80.000	80.000	10.000
26	14	Offset Stripline 1B2A	13	15	5.400	0.000	0.000	40.120	40.000	10.000
		07 . 0.1 5 . 1001	10					10.010	50.000	40.000
27	14	Offset Stripline 1B2A	13	15	3.600	0.000	0.000	49.810	50.000	10.000
28	14	Edge Coupled Offset Stripline 1B2A	13	15	3.500	9.000	0.000	99.770	100.000	10.000
29	14	Edge Coupled Offset Stripline 1B2A	13	15	4.500	5.500	0.000	85.040	85.000	10.000
20	14	Edge Coupled Offeet Sticking 1024	10	15	4.000	5.400	0.000	90.070	90.000	10.000
30	14	Edge Coupled Offset Stripline 1B2A	13	15	4.000	5.400	0.000	90.070	90.000	10.000
31	16	Coated Microstrip 1B	15	0	9.400	0.000	0.000	40.100	40.000	10.000
32	16	Coated Microstrip 1B	15	0	6.250	0.000	0.000	50.000	50.000	10.000
33	16	Edge Coupled Coated Microstrip 1B	15	0	6.500	4.500	0.000	79.640	80.000	10.000
	10	Edge Coupled Coated Microsoft TB	15	0	0.500	4.300	0.000	79.040		
34	16	Edge Coupled Coated Microstrip 1B	15	0	5.600	4.500	0.000	84.850	85.000	10.000
35	16	Edge Coupled Coated Microstrip 1B	15	0	4.800	4.500	0.000	90.200	90.000	10.000
36	16	Edge Coupled Coated Microstrip 1B	15	0	4.200	5.700	0.000	100.120	100.000	10.000
30	10	Euge Coupled Coated Microstrip TB	15	0	4.200	5.700	0.000	100.120	100.000	10.000

### TWO STAGE PAYMENT

**Stage 1:**40% Payment will be done once the stage 1 is completed and is delivered. **Stage 2**:60% Payment will be done once the stage 2 is completed and is delivered.

# SIGNATURE OF BIDDER ALONG WITH SEAL OF THE COMPANY WITH DATE

## FINANCIAL BID (PROFORMA) - BILL OF QUANTITIES (BOQ)

### Item Name: PCBs Manufacturing and Assembly Tender No: EE/GANT/062/2023/PCBMANASSLY

It. No	Description of work	Quantity	Units	Basic Unit INR	GST in Percentage	Total Amount with taxes in INR
1	SOM BOM Cost	19	Nos.			
2	Integrated Mother Board BOM Cost	6	Nos.			
3	SOM EVK Mother Board BOM Cost	6	Nos.			
4	SOM Fabrication Cost	20	Nos.			
5	Integrated Mother Board Fabrication Cost	7	Nos.			
	SOM EVK Mother Board Fabrication Cost	7	Nos.			
7	SOM Assembly Cost	19	Nos.			
8	Integrated Mother Board Assembly Cost	6	Nos.			
9	SOM EVK Mother Board Assembly Cost	6	Nos.			
	Grand	Total		·		

Total Amount Rupees in words

### FORMAT FOR AFFIDAVIT OF SELF-CERTIFICATION UNDER PREFERENCE TO MAKE IN INDIA – PER ITEM

#### **Tender Reference Number:**

#### Name of the item / Service:

Date:	
I/We	_S/o, D/o, W/o,
Resident of	

Hereby solemnly affirm and declare as under:

That I will agree to abide by the terms and conditions of the Public Procurement (Preference to Make in India) Policy vide GoI Order no. P-45021/2/2017-PP (B.E.-II) dated 15.06.2017 (subsequently revised vide orders dated 28.05.2018, 29.05.2019and 04.06.2020) MOCI order No. 45021/2/2017-PP (BE II) Dt.16th September 2020 & P-45021/102/2019-BE-II-Part (1) (E-50310) Dt.4th March 2021 and any subsequent modifications/Amendments, if any and

That the local content for all inputs which constitute the said item/service/work has been verified by me and I am responsible for the correctness of the claims made therein.

Tick (🗸	() and Fill the Appropriate Category
	I/We[name of the supplier] hereby confirm in respect of quoted items
	thatLocal Content is equal to or more than 50% and come under "Class-I Local Supplier"
	category.
	I/We [name of the supplier] hereby confirm in respect of quoted items
	that Local Content is equal to 20% but less than 50% and come under "Class-II Local Supplier"
	category.
• Th	e details of the location (s) at which the local value addition is made and the proportionate value of 1

• The details of the location (s) at which the local value addition is made and the proportionate value of local content in percentage

Address \_\_\_\_\_ \_\_\_

Percentage of Local content: \_\_\_\_\_%

For and on behalf of......(Name of firm/entity)

Authorized signatory (To be duly authorized by the Board of Directors) <Insert Name, Designation and Contact No.>

[Note: In case of procurement for a value in excess of Rs. 10 Crores, the bidders shall provide this certificate from statutory auditor or cost auditor of the company (in the case of companies) or from a practicing cost accountant or practicing chartered accountant (in respect of suppliers other than companies) giving the percentage of local content.]

### This letter should be on the letterhead of the quoting firm and should be signed by a competent authority. Nonsubmission of this will lead to Disqualification of bids.

(To be given on the letter head of the bidder)

No.

Dated: \_\_\_\_\_

### **CERTIFICATE**

(Bidders from India)

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and hereby certify that I am not from such a country.

### OR (whichever is applicable)

### (Bidders from Country which shares a land border with India)

I have read the clause regarding restrictions on procurement from a bidder of a country which shares a land border with India and hereby certify that I from \_\_\_\_\_\_ (Name of Country) and has been registered with the Competent Authority. I also certify that I fulfil all the requirements in this regard and is eligible to be considered. (*Copy/ evidence of valid registration by the Competent Authority is to be attached*)

Place: Date: Signature of the Tenderer Name & Address of the Tenderer with

Office Stamp

### ANNEXURE - F

#### OEM CERTIFICATION FORM (In Original Letter Head of OEM)

Tender No:	Dated:
We are Original Equipment Manufacturers (OEM) of	(Name of the company)
Ms (Name of the vendor	r) is one of our
Distributors/Dealers/Resellers/Partners (tick one) for the	
aı	nd is participating in the above-
mentioned tender by offering our product model	(Name of the product with
model number).	

..... is authorized to bid, sell and provide service support warranty for our product

as mentioned above.

Name and Signature of the authorized signatory of OEM along with seal of the company with Date

\_\_\_\_\_

# <u>TENDER CHECKLIST – Mandatory to be filled and sent (inside the Main Bid Cover)</u> <u>along with Bidding Document.</u>

- (1) I have registered as a Vendor with IC&SR. (Proof to be enclosed)
- (2) Technical bid cover and Financial Bid cover to be submitted separated.
- (3) Completed and **Signed Form of Tender**. The Form of Tender document shall be signed by a person legally authorized.
- (4) Completed Technical Compliance Statement
- (5) Certification of Class I / Class II (As a part of technical bid) per item / service / work as per (Annexure D)
- (6) EMD (Ref. tender document pg.no. 6, Point no.9)
- (7) Land Border (Annexure  $\mathbf{E}$ )
- (8) Authorized agent certificate from OEM is mandatory if Indian agent/Indian office of OEM is participating in this tender on behalf of OEM.

The bid will be valid only if all the above documents are provided. Bidders are asked to supply and tick off the required information. Failure to provide any of the stated documents may result in the bid being considered as non-compliant and rejected.

Signature of the Bidder

### FORM - A NON-BLACKLISTING DECLARATION

Date: XXXX

To, The Indian Institute of Technology Madras, Sardar Patel road, Guindy, Chennai - 600036

### 

Dear Sir,

a. We are not involved in any major litigation that may have an impact of affecting or compromising the delivery of services as required under this assignment.

b. We are not blacklisted by any Central/ State Government/ agency of Central/ State Government of India or any other country in the world/ Public Sector Undertaking/ any Regulatory Authorities in India or any other country in the world for any kind of fraudulent activities in last XX years.

Sincerely,

[BIDDERS NAME] Name Title Signature



CENTRE FOR INDUSTRIAL CONSULTANCY & SPONSORED RESEARCH (IC&SR) INDIAN INSTITUTE OF TECHNOLOGY MADRAS CHENNAI 600 036



## ELECTRONIC CLEARING SERVICE (Credit Clearing)/ REAL TIME GROSS SETTLEMENT (RTGS) FACILITY FOR RECEIVING PAYMENTS A. Details of Account Holder

Name of the Institution	Indian Institute of Technology - Madras
Complete Contact Address	Industrial Consultancy and Sponsored Research Indian Institute of Technology-Madras, IIT- Madras Campus Post Office, Sardar Patel Road, Guindy, CHENNAI - 600 036
Telephone No./ Fax No.	Tel - 044-2257 8356
E- mail ID of the FO/AO/REG/DIR	dricsr@iitm.ac.in

### B. Bank Account Details:

Institution Account Name (As per Bank	The Registrar, Indian Institute of
Record)	Technology - Madras
Account No.	2722101003872
Account Print Name	IIT F A/C , The Registrar IIT Madras
IFSC CODE	CNRB0002722
Bank Name (in full)	Canara Bank
Branch Name	IIT-Madras Branch
Complete Branch Address	Canara Bank, IIT-Madras Branch,
	IIT- Madras Campus Post Office,
	Sardar Patel Road,
	Guindy, CHENNAI - 600 036
MICR No.	600015085
Account Type	Savings Account

Certified that the Institute's account is in an RTGS enabled branch.

I hereby declare that the particulars given above are correct and complete.

Date:

Signature of the competent Authority of the Institution with seal.

#### **MANDATE FORM**

# ELECTRONICS CLEARING SERVICE (CREDIT CLEARING)/REAL TIME GROSS SETTLEMENT (RTGS) FACILITY FOR RECEIVING PAYMENTS.

#### \*\*\*\*

#### A. DETAILS OF ACCOUNT HOLDER:-

NAME OF ACCOUNT HOLDER	
COMPLETE CONTACT ADDRESS	
TELEPHONE NUMBER/FAX/E MAIL	

#### B. BANK ACCOUNT DETAILS:-

BANK NAME	
BRANCH NAME WITH COMPLETE ADDRESS, TELEPHONE NUMBER AND EMAIL	
WHETHER THE BRANCH IS COMPUTERISED?	
WHETHER THE NRANCH IS RTGS ENABLED? IF YES,	
THEN WHAT IS THE BRANCH IFSC CODE	
IS THE BRANCH ALSO NEFT ENABLED?	
TYPE OF BANK ACCOUNT(SB/CURRENT/CASH CREDIT)	
COMPLETE BANK ACCOUNT NUMBER(LATEST)	
MICR CODE OF BANK	

#### DATE OF EFFECT:

I hereby declare that the particulars given above are correct and complete. If the transaction is delayed or not effected at all for reasons of incomplete or incorrect information I would not hold the user institution responsible. I have read the option invitation letter and agree to discharge responsibility expected of me as a participant under the Scheme.

(.....)

Signature of Customer

Date: Certified that the particulars furnished above are correct as per our records. (Bank's Stamp)

(.....)

Signature of Customer

#### Date :

- 1. Please attach a photocopy of cheque along with the verification obtained from the bank.
- 2. In case your Bank Branch is presently not "RTGS enabled", then upon its up gradation to "RTGS Enabled" branch, please submit the information again in the above proforma to the Department at earliest.